

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y

EXCALIBUR LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

- **Outstanding Combination of dc Precision and AC Performance:**

Unity-Gain Bandwidth . . . 15 MHz Typ

V_n 3.3 nV/ $\sqrt{\text{Hz}}$ at $f = 10$ Hz Typ,
2.5 nV/ $\sqrt{\text{Hz}}$ at $f = 1$ kHz Typ

V_{IO} 25 μV Max

A_{VD} 45 V/ μV Typ With $R_L = 2$ k Ω ,
19 V/ μV Typ With $R_L = 600$ Ω

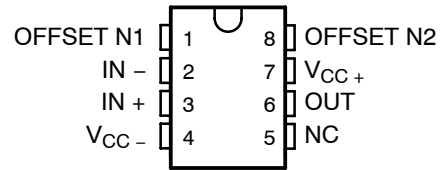
- Available in Standard-Pinout Small-Outline Package
- Output Features Saturation Recovery Circuitry
- Macromodels and Statistical information

description

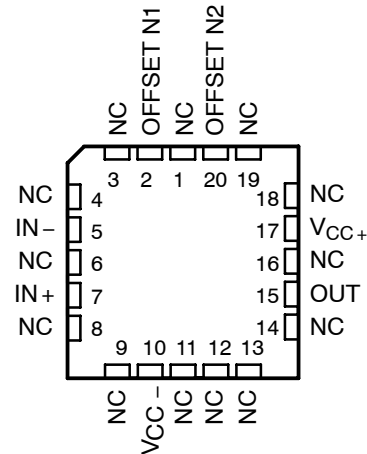
The TLE20x7 and TLE20x7A contain innovative circuit design expertise and high-quality process control techniques to produce a level of ac performance and dc precision previously unavailable in single operational amplifiers. Manufactured using Texas Instruments state-of-the-art Excalibur process, these devices allow upgrades to systems that use lower-precision devices.

In the area of dc precision, the TLE20x7 and TLE20x7A offer maximum offset voltages of 100 μV and 25 μV , respectively, common-mode rejection ratio of 131 dB (typ), supply voltage rejection ratio of 144 dB (typ), and dc gain of 45 V/ μV (typ).

D, JG, OR P PACKAGE
(TOP VIEW)



FK PACKAGE
(TOP VIEW)



AVAILABLE OPTIONS

T_A	V_{IOmax} AT 25°C	PACKAGED DEVICES				CHIP FORM [‡] (Y)
		SMALL OUTLINE [†] (D)	CHIP CARRIER (FK)	CERAMIC DIP (JG)	PLASTIC DIP (P)	
0°C to 70°C	25 μV	TLE2027ACD TLE2037ACD	— —	— —	TLE2027ACP TLE2037ACP	TLE2027Y TLE2037Y
	100 μV	TLE2027CD TLE2037CD	— —	— —	TLE2027CP TLE2037CP	TLE2027Y TLE2037Y
–40°C to 105°C	25 μV	TLE2027AID TLE2037AID	— —	— —	TLE2027AIP TLE2037AIP	—
	100 μV	TLE2027ID TLE2037ID	— —	— —	TLE2027IP TLE2037IP	—
–55°C to 125°C	25 μV	TLE2027AMD TLE2037AMD	TLE2027AMFK TLE2037AMFK	TLE2027AMJG TLE2037AMJG	TLE2027AMP TLE2037AMP	—
	100 μV	TLE2027MD TLE2037MD	TLE2027MFK TLE2037MFK	TLE2027MJG TLE2037MJG	TLE2027MP TLE2037MP	—

[†] The D packages are available taped and reeled. Add R suffix to device type (e.g., TLE2027ACDR).

[‡] Chip forms are tested at 25°C only.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

All trademarks are the property of their respective owners.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



Copyright © 2002–2006, Texas Instruments Incorporated

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y

EXCALIBUR LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL AMPLIFIERS

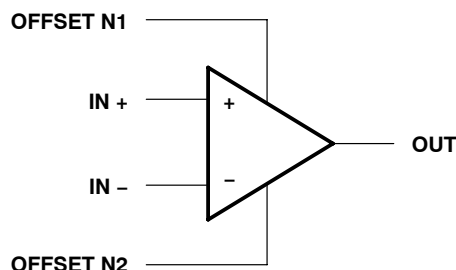
SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

description (continued)

The ac performance of the TLE2027 and TLE2037 is highlighted by a typical unity-gain bandwidth specification of 15 MHz, 55° of phase margin, and noise voltage specifications of 3.3 nV/ $\sqrt{\text{Hz}}$ and 2.5 nV/ $\sqrt{\text{Hz}}$ at frequencies of 10 Hz and 1 kHz respectively. The TLE2037 and TLE2037A have been decompensated for faster slew rate ($-7.5 \text{ V}/\mu\text{s}$, typical) and wider bandwidth (50 MHz). To ensure stability, the TLE2037 and TLE2037A should be operated with a closed-loop gain of 5 or greater.

Both the TLE20x7 and TLE20x7A are available in a wide variety of packages, including the industry-standard 8-pin small-outline version for high-density system applications. The C-suffix devices are characterized for operation from 0°C to 70°C. The I-suffix devices are characterized for operation from -40°C to 105°C . The M-suffix devices are characterized for operation over the full military temperature range of -55°C to 125°C .

symbol

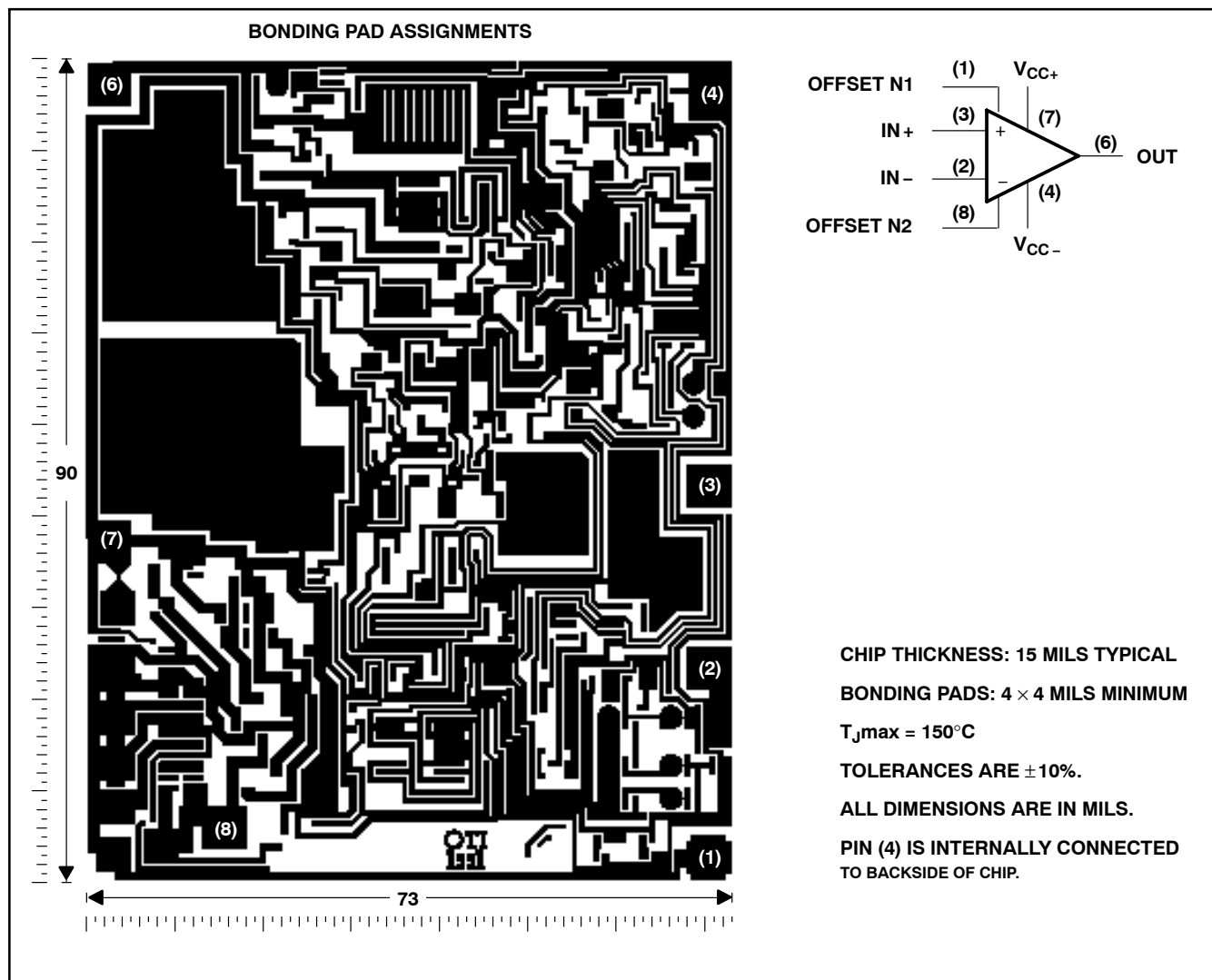


TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y EXCALIBUR LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

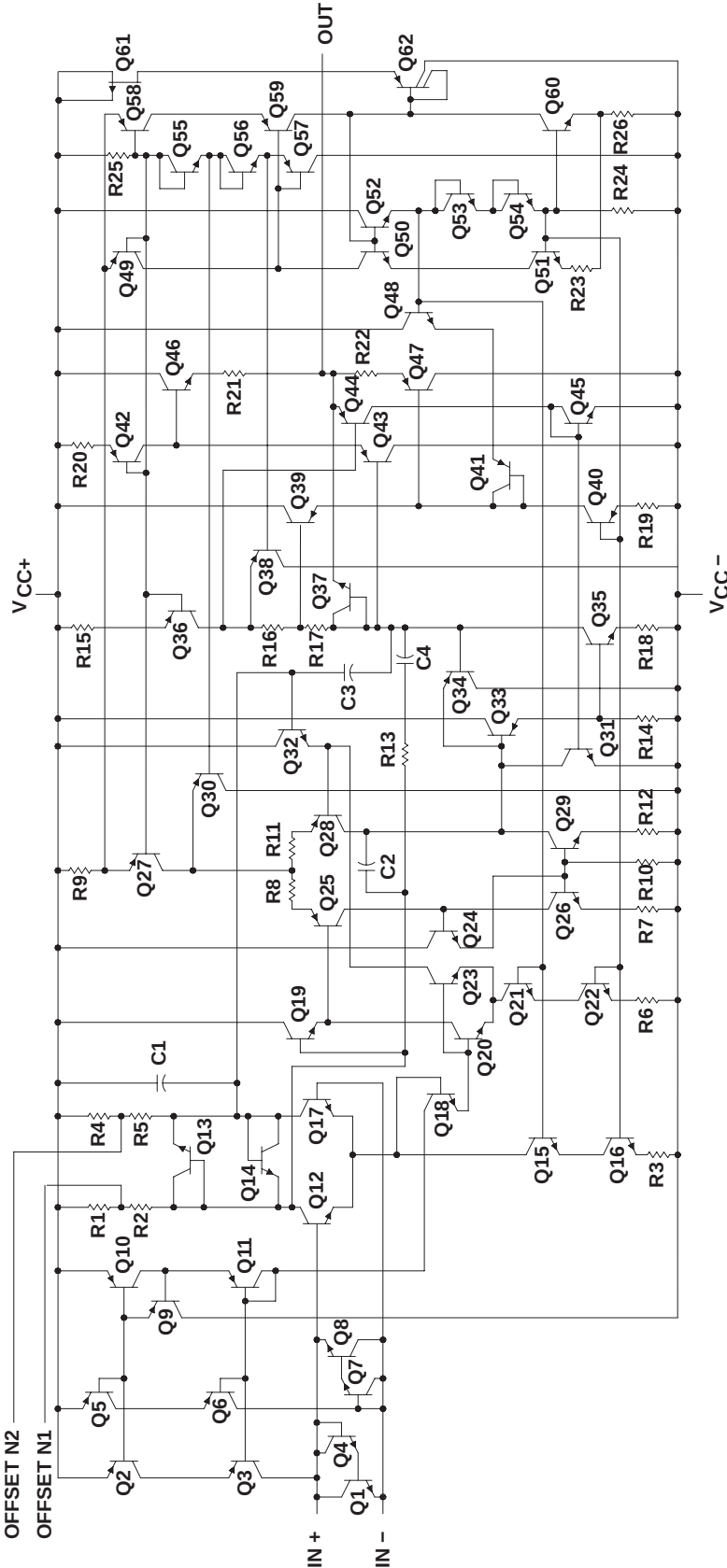
TLE202xY chip information

This chip, when properly assembled, displays characteristics similar to the TLE202xC. Thermal compression or ultrasonic bonding may be used on the doped-aluminum bonding pads. The chip may be mounted with conductive epoxy or a gold-silicon preform.



TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y
EXCALIBUR LOW-NOISE HIGH-SPEED
PRECISION OPERATIONAL AMPLIFIERS
SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

equivalent schematic



ACTUAL DEVICE COMPONENT COUNT			
COMPONENT	TLE2027	TLE2037	
Transistors	61	61	
Resistors	26	26	
epiFET	1	1	
Capacitors	4	4	

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y
EXCALIBUR LOW-NOISE HIGH-SPEED
PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V_{CC+} (see Note 1)	19 V
Supply voltage, V_{CC-}	– 19 V
Differential input voltage, V_{ID} (see Note 2)	± 1.2 V
Input voltage range, V_I (any input)	$V_{CC\pm}$
Input current, I_I (each Input)	± 1 mA
Output current, I_O	± 50 mA
Total current into V_{CC+}	50 mA
Total current out of V_{CC-}	50 mA
Duration of short-circuit current at (or below) 25°C (see Note 3)	unlimited
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T_A : C suffix	0°C to 70°C
I suffix	– 40°C to 105°C
M suffix	– 55°C to 125°C
Storage temperature range, T_{stg}	– 65°C to 150°C
Case temperature for 60 seconds, T_C : FK package	260°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D or P package	260°C
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: JG package	300°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values, except differential voltages, are with respect to the midpoint between V_{CC+} and V_{CC-} .
 2. Differential voltages are at $IN+$ with respect to $IN-$. Excessive current flows if a differential input voltage in excess of approximately ± 1.2 V is applied between the inputs unless some limiting resistance is used.
 3. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING	$T_A = 105^\circ\text{C}$ POWER RATING	$T_A = 125^\circ\text{C}$ POWER RATING
D	725 mW	5.8 mW/°C	464 mW	261 mW	145 mW
FK	1375 mW	11.0 mW/°C	880 mW	495 mW	275 mW
JG	1050 mW	8.4 mW/°C	672 mW	378 mW	210 mW
P	1000 mW	8.0 mW/°C	640 mW	360 mW	200 mW

recommended operating conditions

		C SUFFIX		I SUFFIX		M SUFFIX		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
Supply voltage, $V_{CC\pm}$		± 4	± 19	± 4	± 19	± 4	± 19	V
Common-mode input voltage, V_{IC}	$T_A = 25^\circ\text{C}$	– 11	11	– 11	11	– 11	11	V
	$T_A = \text{Full range}^\ddagger$	– 10.5	10.5	– 10.4	10.4	– 10.2	10.2	
Operating free-air temperature, T_A		0	70	– 40	105	– 55	125	°C

[‡] Full range is 0°C to 70°C for C-suffix devices, – 40°C to 105°C for I-suffix devices, and – 55°C to 125°C for M-suffix devices.

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y

EXCALIBUR LOW-NOISE HIGH-SPEED

PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TLE20x7C electrical characteristics at specified free-air temperature, $V_{CC\pm} = \pm 15$ V (unless otherwise noted)

PARAMETER	TEST CONDITIONS	$T_A^\dagger$	TLE20x7C			TLE20x7AC			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO} Input offset voltage	$V_{IC} = 0, R_S = 50 \Omega$	25°C	20	100		10	25		μV
		Full range		145			70		
α_{VIO} Temperature coefficient of input offset voltage		Full range	0.4	1		0.2	1		$\mu V/^\circ C$
Input offset voltage long-term drift (see Note 4)		25°C	0.006	1		0.006	1		$\mu V/mo$
I_{IO} Input offset current		25°C	6	90		6	90		nA
		Full range		150			150		
I_{IB} Input bias current		25°C	15	90		15	90		nA
		Full range		150			150		
V_{ICR} Common-mode input voltage range	$R_S = 50 \Omega$	25°C	–11 to 11	–13 to 13		–11 to 11	–13 to 13		V
		Full range	–10.5 to 10.5			–10.5 to 10.5			
V_{OM+} Maximum positive peak output voltage swing	$R_L = 600 \Omega$	25°C	10.5	12.9		10.5	12.9		V
		Full range	10			10			
	$R_L = 2 k\Omega$	25°C	12	13.2		12	13.2		
		Full range	11			11			
V_{OM-} Maximum negative peak output voltage swing	$R_L = 600 \Omega$	25°C	–10.5	–13		–10.5	–13		V
		Full range	–10			–10			
	$R_L = 2 k\Omega$	25°C	–12	–13.5		–12	–13.5		
		Full range	–11			–11			
A_{VD} Large-signal differential voltage amplification	$V_O = \pm 11$ V, $R_L = 2 k\Omega$	25°C	5	45		10	45		V/ μV
	$V_O = \pm 10$ V, $R_L = 2 k\Omega$	Full range	2			4			
	$V_O = \pm 10$ V, $R_L = 1 k\Omega$	25°C	3.5	38		8	38		
		Full range	1			2.5			
	$V_O = \pm 10$ V, $R_L = 600 \Omega$	25°C	2	19		5	19		
		Full range	0.5			2			
C_i Input capacitance		25°C	8			8			pF
z_o Open-loop output impedance	$I_O = 0$	25°C	50			50			Ω
CMRR Common-mode rejection ratio	$V_{IC} = V_{ICRmin}, R_S = 50 \Omega$	25°C	100	131		117	131		dB
		Full range	98			114			
k_{SVR} Supply-voltage rejection ratio ($\Delta V_{CC\pm} / \Delta V_{IO}$)	$V_{CC\pm} = \pm 4$ V to ± 18 V, $R_S = 50 \Omega$	25°C	94	144		110	144		dB
	$V_{CC\pm} = \pm 4$ V to ± 18 V, $R_S = 50 \Omega$	Full range	92			106			
I_{CC} Supply current	$V_O = 0, \text{ No load}$	25°C	3.8	5.3		3.8	5.3		mA
		Full range		5.6			5.6		

† Full range is 0°C to 70°C.

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at $T_A = 150^\circ C$ extrapolated to $T_A = 25^\circ C$ using the Arrhenius equation and assuming an activation energy of 0.96 eV.

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y
EXCALIBUR LOW-NOISE HIGH-SPEED
PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TLE20x7C operating characteristics at specified free-air temperature, $V_{CC} \pm = \pm 15\text{ V}$, $T_A = 25^\circ\text{C}$ (unless otherwise specified)

PARAMETER		TEST CONDITIONS		TLE20x7C			TLE20x7AC			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
SR	Slew rate at unity gain	$R_L = 2\text{ k}\Omega$, $C_L = 100\text{ pF}$, See Figure 1	TLE2027	1.7	2.8		1.7	2.8		V/ μs
			TLE2037	6	7.5		6	7.5		
		$R_L = 2\text{ k}\Omega$, $C_L = 100\text{ pF}$, $T_A = 0^\circ\text{C}$ to 70°C , See Figure 1	TLE2027	1.2			1.2			
			TLE2037	5			5			
V_n	Equivalent input noise voltage (see Figure 2)	$R_S = 20\text{ }\Omega$, $f = 10\text{ Hz}$			3.3	8		3.3	4.5	nV/ $\sqrt{\text{Hz}}$
		$R_S = 20\text{ }\Omega$, $f = 1\text{ kHz}$			2.5	4.5		2.5	3.8	
$V_{N(PP)}$	Peak-to-peak equivalent input noise voltage	$f = 0.1\text{ Hz}$ to 10 Hz			50	250		50	130	nV
I_n	Equivalent input noise current	$f = 10\text{ Hz}$			10	25		10	25	pA/ $\sqrt{\text{Hz}}$
		$f = 1\text{ kHz}$			0.8	1.8		0.8	1.8	
THD	Total harmonic distortion	$V_O = +10\text{ V}$, $A_{VD} = 1$, See Note 5	TLE2027	< 0.002%			< 0.002%			
		$V_O = +10\text{ V}$, $A_{VD} = 5$, See Note 5	TLE2037	< 0.002%			< 0.002%			
B_1	Unity-gain bandwidth (see Figure 3)	$R_L = 2\text{ k}\Omega$, $C_L = 100\text{ pF}$	TLE2027	9 ⁽⁶⁾	13		9 ⁽⁶⁾	13		MHz
GBW	Gain bandwidth product	$R_L = 2\text{ k}\Omega$, $C_L = 100\text{ pF}$	TLE2037	35	50		35	50		
B_{OM}	Maximum output-swing bandwidth	$R_L = 2\text{ k}\Omega$	TLE2027	30			30			kHz
			TLE2037	80			80			
ϕ_m	Phase margin at unity gain (see Figure 3)	$R_L = 2\text{ k}\Omega$, $C_L = 100\text{ pF}$	TLE2027	55°			55°			
			TLE2037	50°			50°			

NOTE 5: Measured distortion of the source used in the analysis was 0.002%.

NOTE 6: This parameter is not production tested

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y

EXCALIBUR LOW-NOISE HIGH-SPEED

PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TLE20x7I electrical characteristics at specified free-air temperature, $V_{CC\pm} = \pm 15$ V (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T _A [†]	TLE20x7I			TLE20x7AI			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
V _{IO}	Input offset voltage	V _{IC} = 0, R _S = 50 Ω	25°C	20 100		10 25		μV		
			Full range	180		105				
α _{VIO}	Temperature coefficient of input offset voltage		Full range	0.4 1		0.2 1		μV/°C		
	Input offset voltage long-term drift (see Note 4)		25°C	0.006 1		0.006 1		μV/mo		
I _{IO}	Input offset current		25°C	6 90		6 90		nA		
			Full range	150		150				
I _{IB}	Input bias current		25°C	15 90		15 90		nA		
			Full range	150		150				
V _{ICR}	Common-mode input voltage range	R _S = 50 Ω	25°C	–11 to 11	–13 to 13	–11 to 11	–13 to 13	V		
			Full range	–10.4 to 10.4		–10.4 to 10.4				
V _{OM} +	Maximum positive peak output voltage swing	R _L = 600 Ω	25°C	10.5	12.9	10.5	12.9	V		
			Full range	10		10				
		R _L = 2 kΩ	25°C	12	13.2	12	13.2			
			Full range	11		11				
V _{OM} –	Maximum negative peak output voltage swing	R _L = 600 Ω	25°C	–10.5	–13	–10.5	–13	V		
			Full range	–10		–10				
		R _L = 2 kΩ	25°C	–12	–13.5	–12	–13.5			
			Full range	–11		–11				
A _{VD}	Large-signal differential voltage amplification	V _O = ±11 V, R _L = 2 kΩ	25°C	5	45	10	45	V/μV		
		V _O = ±10 V, R _L = 2 kΩ	Full range	2		3.5				
		V _O = ±10 V, R _L = 1 kΩ	25°C	3.5	38	8	38			
			Full range	1		2.2				
		V _O = ±10 V, R _L = 600 Ω	25°C	2	19	5	19			
			Full range	0.5		1.1				
C _i	Input capacitance		25°C	8		8		pF		
z _o	Open-loop output impedance	I _O = 0	25°C	50		50		Ω		
CMRR	Common-mode rejection ratio	V _{IC} = V _{ICRmin} , R _S = 50 Ω	25°C	100	131	117	131	dB		
			Full range	96		113				
k _{SVR}	Supply-voltage rejection ratio (ΔV _{CC±} /ΔV _{IO})	V _{CC±} = ±4 V to ±18 V, R _S = 50 Ω	25°C	94	144	110	144	dB		
		V _{CC±} = ±4 V to ±18 V, R _S = 50 Ω	Full range	90		105				
I _{CC}	Supply current	V _O = 0, No load	25°C	3.8 5.3		3.8 5.3		mA		
			Full range	5.6		5.6				

† Full range is –40°C to 105°C.

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at $T_A = 150^\circ C$ extrapolated to $T_A = 25^\circ C$ using the Arrhenius equation and assuming an activation energy of 0.96 eV.

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y
EXCALIBUR LOW-NOISE HIGH-SPEED
PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TLE20x7I operating characteristics at specified free-air temperature, $V_{CC\pm} = \pm 15\text{ V}$, $T_A = 25^\circ\text{C}$ (unless otherwise specified)

PARAMETER	TEST CONDITIONS		TLE20x7I			TLE20x7AI			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
SR	Slew rate at unity gain	R _L = 2 kΩ, C _L = 100 pF, See Figure 1	TLE2027	1.7	2.8		1.7	2.8	V/μs
		TLE2037	6	7.5		6	7.5		
		R _L = 2 kΩ, C _L = 100 pF, T _A = −40°C to 85°C, See Figure 1	TLE2027	1.1			1.1		
		TLE2037	4.7			4.7			
V _n	Equivalent input noise voltage (see Figure 2)	R _S = 20 Ω, f = 10 Hz		3.3	8		3.3	4.5	nV/√Hz
		R _S = 20 Ω, f = 1 kHz		2.5	4.5		2.5	3.8	
V _{N(PP)}	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 10 Hz		50	250		50	130	nV
I _n	Equivalent input noise current	f = 10 Hz		10	25		10	25	pA/√Hz
		f = 1 kHz		0.8	1.8		0.8	1.8	
THD	Total harmonic distortion	V _O = +10 V, A _{VD} = 1, See Note 5	TLE2027	< 0.002%			< 0.002%		
		V _O = +10 V, A _{VD} = 5, See Note 5	TLE2037	< 0.002%			< 0.002%		
B ₁	Unity-gain bandwidth (see Figure 3)	R _L = 2 kΩ, C _L = 100 pF	TLE2027	9 ⁽⁶⁾	13		9 ⁽⁶⁾	13	MHz
GBW	Gain bandwidth product	R _L = 2 kΩ, C _L = 100 pF	TLE2037	35	50		35	50	
B _{OM}	Maximum output-swing bandwidth	R _L = 2 kΩ	TLE2027	30			30		kHz
			TLE2037	80			80		
ϕ _m	Phase margin at unity gain (see Figure 3)	R _L = 2 kΩ, C _L = 100 pF	TLE2027	55°			55°		
			TLE2037	50°			50°		

NOTE 5: Measured distortion of the source used in the analysis was 0.002%.

NOTE 6: This parameter is not production tested.

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y

EXCALIBUR LOW-NOISE HIGH-SPEED

PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TLE20x7M electrical characteristics at specified free-air temperature, $V_{CC\pm} = \pm 15$ V (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T _A [†]	TLE20x7M			TLE20x7AM			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
V _{IO}	Input offset voltage	V _{IC} = 0, R _S = 50 Ω	25°C	20	100	10	25	μV		
			Full range	200			105			
α _{VIO}	Temperature coefficient of input offset voltage		Full range	0.4	1*	0.2	1*	μV/°C		
	Input offset voltage long-term drift (see Note 4)		25°C	0.006	1*	0.006	1*	μV/mo		
I _{IO}	Input offset current		25°C	6	90	6	90	nA		
			Full range	150			150			
I _{IB}	Input bias current		25°C	15	90	15	90	nA		
			Full range	150			150			
V _{ICR}	Common-mode input voltage range	R _S = 50 Ω	25°C	–11 to 11	–13 to 13	–11 to 11	–13 to 13	V		
			Full range	–10.3 to 10.3		–10.4 to 10.4				
V _{OM} +	Maximum positive peak output voltage swing	R _L = 600 Ω	25°C	10.5	12.9	10.5	12.9	V		
			Full range	10			10			
		R _L = 2 kΩ	25°C	12	13.2	12	13.2			
			Full range	11			11			
V _{OM} –	Maximum negative peak output voltage swing	R _L = 600 Ω	25°C	–10.5	–13	–10.5	–13	V		
			Full range	–10			–10			
		R _L = 2 kΩ	25°C	–12	–13.5	–12	–13.5			
			Full range	–11			–11			
A _{VD}	Large-signal differential voltage amplification	V _O = ±11 V, R _L = 2 kΩ	25°C	5	45	10	45	V/μV		
		V _O = ±10 V, R _L = 2 kΩ	Full range	2.5			3.5			
		V _O = ±10 V, R _L = 1 kΩ	25°C	3.5	38	8	38			
		Full range	1.8			2.2				
		V _O = ±10 V, R _L = 600 Ω	25°C	2	19	5	19			
C _i	Input capacitance		25°C	8			8		pF	
z _o	Open-loop output impedance	I _O = 0	25°C	50			50		Ω	
CMRR	Common-mode rejection ratio	V _{IC} = V _{ICRmin} , R _S = 50 Ω	25°C	100	131	117	131	dB		
			Full range	96			113			
k _{SVR}	Supply-voltage rejection ratio (ΔV _{CC±} /ΔV _{IO})	V _{CC±} = ±4 V to ±18 V, R _S = 50 Ω	25°C	94	144	110	144	dB		
		V _{CC±} = ±4 V to ±18 V, R _S = 50 Ω	Full range	90			105			
I _{CC}	Supply current	V _O = 0, No load	25°C	3.8	5.3	3.8	5.3	mA		
			Full range	5.6			5.6			

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

† Full range is –55°C to 125°C.

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at $T_A = 150^\circ C$ extrapolated to $T_A = 25^\circ C$ using the Arrhenius equation and assuming an activation energy of 0.96 eV.

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y
EXCALIBUR LOW-NOISE HIGH-SPEED
PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TLE20x7M operating characteristics at specified free-air temperature, $V_{CC} \pm = \pm 15\text{ V}$, $T_A = 25^\circ\text{C}$ (unless otherwise specified)

PARAMETER		TEST CONDITIONS		TLE20x7M			TLE20x7AM			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
SR	Slew rate at unity gain	R _L = 2 kΩ, C _L = 100 pF, See Figure 1	TLE2027	1.7	2.8		1.7	2.8		V/μs
			TLE2037	6*	7.5		6*	7.5		
		R _L = 2 kΩ, C _L = 100 pF, T _A = −55°C to 125°C, See Figure 1	TLE2027	1			1			
			TLE2037	4.4*			4.4*			
V _n	Equivalent input noise voltage (see Figure 2)	R _S = 20 Ω, f = 10 Hz		3.3	8*		3.3	8*	nV/√Hz	
		R _S = 20 Ω, f = 1 kHz		2.5	4*		2.5	4*		
V _{N(PP)}	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 10 Hz		225	375*		225	375*	nV	
I _n	Equivalent input noise current	f = 10 Hz		25			25		pA/√Hz	
		f = 1 kHz		2.5			2.5			
THD	Total harmonic distortion	V _O = +10 V, A _{VD} = 1, See Note 5	TLE2027	< 0.002%			< 0.002%			
		V _O = +10 V, A _{VD} = 5, See Note 5	TLE2037	< 0.002%			< 0.002%			
B ₁	Unity-gain bandwidth (see Figure 3)	R _L = 2 kΩ, C _L = 100 pF	TLE2027	7*	13		9*	13	MHz	
			TLE2037	35	50		35	50		
B _{OM}	Maximum output-swing bandwidth	R _L = 2 kΩ	TLE2027	30			30			kHz
			TLE2037	80			80			
ϕ _m	Phase margin at unity gain (see Figure 3)	R _L = 2 kΩ, C _L = 100 pF	TLE2027	55°			55°			
			TLE2037	50°			50°			

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

NOTE 5: Measured distortion of the source used in the analysis was 0.002%.

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y

EXCALIBUR LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TLE20x7Y electrical characteristics, $V_{CC\pm} = \pm 15\text{ V}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TLE20x7Y			UNIT
		MIN	TYP	MAX	
V_{IO} Input offset voltage	$V_{IC} = 0$, $R_S = 50\ \Omega$		20		μV
Input offset voltage long-term drift (see Note 4)			0.006		$\mu\text{V}/\text{mo}$
I_{IO} Input offset current			6		nA
I_{IB} Input bias current			15		nA
V_{ICR} Common-mode input voltage range	$R_S = 50\ \Omega$		-13 to 13		V
V_{OM+} Maximum positive peak output voltage swing	$R_L = 600\ \Omega$		12.9		V
	$R_L = 2\ \text{k}\Omega$		13.2		
V_{OM-} Maximum negative peak output voltage swing	$R_L = 600\ \Omega$		-13		V
	$R_L = 2\ \text{k}\Omega$		-13.5		
A_{VD} Large-signal differential voltage amplification	$V_O = \pm 11\text{ V}$, $R_L = 2\ \text{k}\Omega$		45		V/ μV
	$V_O = \pm 10\text{ V}$, $R_L = 1\ \text{k}\Omega$		38		
	$V_O = \pm 10\text{ V}$, $R_L = 600\ \Omega$		19		
C_i Input capacitance			8		pF
z_o Open-loop output impedance	$I_O = 0$		50		Ω
CMRR Common-mode rejection ratio	$V_{IC} = V_{ICR\text{min}}$, $R_S = 50\ \Omega$		131		dB
k_{SVR} Supply-voltage rejection ratio ($\Delta V_{CC\pm} / \Delta V_{IO}$)	$V_{CC\pm} = \pm 4\text{ V}$ to $\pm 18\text{ V}$, $R_S = 50\ \Omega$		144		dB
I_{CC} Supply current	$V_O = 0$, No load		3.8		mA

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at $T_A = 150^\circ\text{C}$ extrapolated to $T_A = 25^\circ\text{C}$ using the Arrhenius equation and assuming an activation energy of 0.96 eV.

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y
EXCALIBUR LOW-NOISE HIGH-SPEED
PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TLE20x7Y operating characteristics at specified free-air temperature, $V_{CC} \pm = \pm 15\text{ V}$

PARAMETER		TEST CONDITIONS		TLE20x7Y			UNIT
				MIN	TYP	MAX	
SR	Slew rate at unity gain	$R_L = 2\text{ k}\Omega$, $C_L = 100\text{ pF}$, See Figure 1	TLE2027		2.8		V/ μs
			TLE2037		7.5		
V_n	Equivalent input noise voltage (see Figure 2)	$R_S = 20\text{ }\Omega$, $f = 10\text{ Hz}$			3.3		nV/ $\sqrt{\text{Hz}}$
		$R_S = 20\text{ }\Omega$, $f = 1\text{ kHz}$			2.5		
$V_{N(PP)}$	Peak-to-peak equivalent input noise voltage	$f = 0.1\text{ Hz to }10\text{ Hz}$			50		nV
I_n	Equivalent input noise current	$f = 10\text{ Hz}$			10		pA/ $\sqrt{\text{Hz}}$
		$f = 1\text{ kHz}$			0.8		
THD	Total harmonic distortion	$V_O = +10\text{ V}$, $A_{VD} = 1$, See Note 5	TLE2027		<0.002%		
		$V_O = +10\text{ V}$, $A_{VD} = 5$, See Note 5	TLE2037		<0.002%		
B_1	Unity-gain bandwidth (see Figure 3)	$R_L = 2\text{ k}\Omega$, $C_L = 100\text{ pF}$	TLE2027		13		MHz
			TLE2037		50		
B_{OM}	Maximum output-swing bandwidth	$R_L = 2\text{ k}\Omega$	TLE2027		30		kHz
			TLE2037		80		
ϕ_m	Phase margin at unity gain (see Figure 3)	$R_L = 2\text{ k}\Omega$, $C_L = 100\text{ pF}$	TLE2027		55°		
			TLE2037		50°		

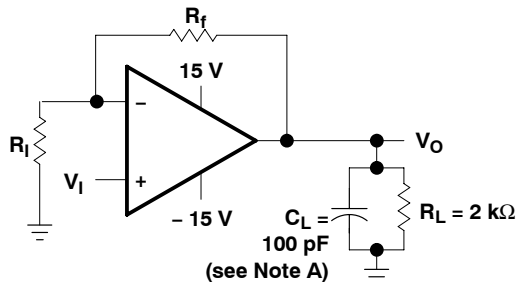
NOTE 5: Measured distortion of the source used in the analysis was 0.002%.

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y

EXCALIBUR LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

PARAMETER MEASUREMENT INFORMATION



NOTE A: C_L includes fixture capacitance.

Figure 1. Slew-Rate Test Circuit

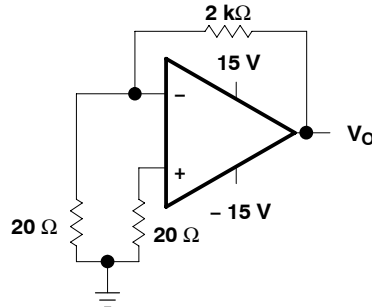
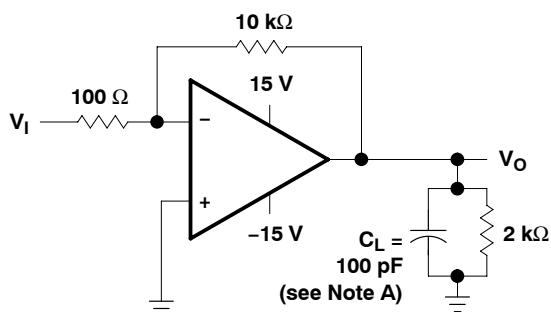
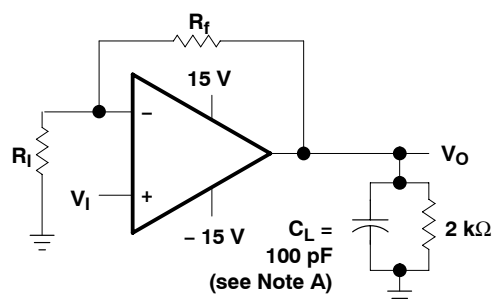


Figure 2. Noise-Voltage Test Circuit



NOTE A: C_L includes fixture capacitance.

Figure 3. Unity-Gain Bandwidth and Phase-Margin Test Circuit (TLE2027 Only)



NOTES: A. C_L includes fixture capacitance.
B. For the TLE2037 and TLE2037A, A_{VD} must be ≥ 5 .

Figure 4. Small-Signal Pulse-Response Test Circuit

typical values

Typical values presented in this data sheet represent the median (50% point) of device parametric performance.

initial estimates of parameter distributions

In the ongoing program of improving data sheets and supplying more information to our customers, Texas Instruments has added an estimate of not only the typical values but also the spread around these values. These are in the form of distribution bars that show the 95% (upper) points and the 5% (lower) points from the characterization of the initial wafer lots of this new device type (see Figure 5). The distribution bars are shown at the points where data was actually collected. The 95% and 5% points are used instead of ± 3 sigma since some of the distributions are not true Gaussian distributions.

The number of units tested and the number of different wafer lots used are on all of the graphs where distribution bars are shown. As noted in Figure 5, there were a total of 835 units from two wafer lots. In this case, there is a good estimate for the within-lot variability and a possibly poor estimate of the lot-to-lot variability. This is always the case on newly released products since there can only be data available from a few wafer lots.

The distribution bars are not intended to replace the minimum and maximum limits in the electrical tables. Each distribution bar represents 90% of the total units tested at a specific temperature. While 10% of the units tested fell outside any given distribution bar, this should not be interpreted to mean that the same individual devices fell outside every distribution bar.

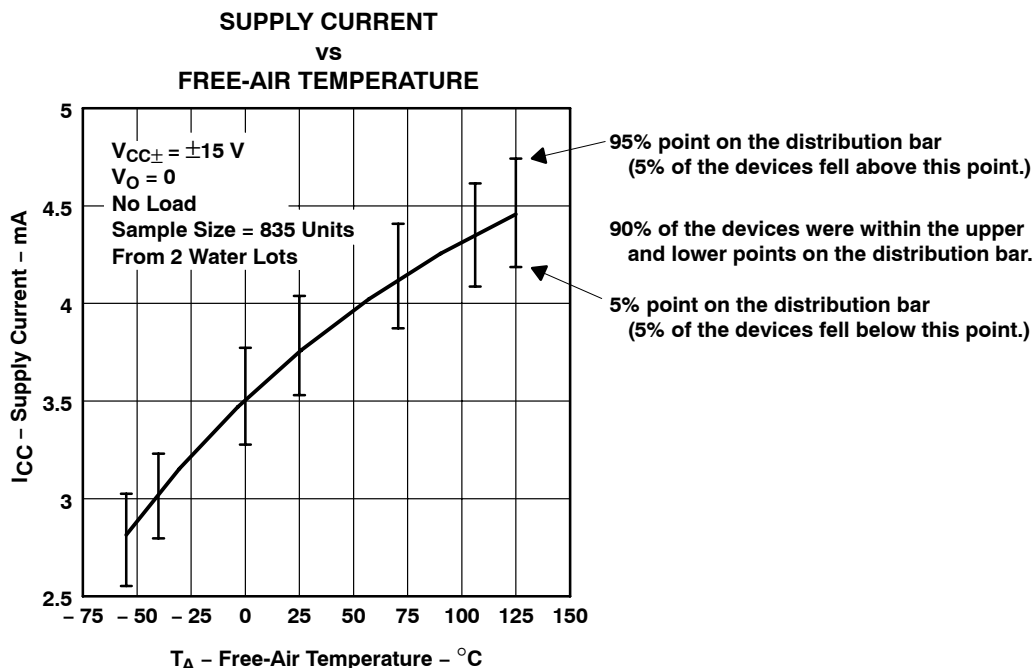


Figure 5. Sample Graph With Distribution Bars

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y

EXCALIBUR LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TYPICAL CHARACTERISTICS

Table of Graphs

			FIGURE
V_{IO}	Input offset voltage	Distribution	6, 7
ΔV_{IO}	Input offset voltage change	vs Time after power on	8, 9
I_{IO}	Input offset current	vs Free-air temperature	10
I_{IB}	Input bias current	vs Free-air temperature	11
		vs Common-mode input voltage	12
I_I	Input current	vs Differential input voltage	13
$V_{O(PP)}$	Maximum peak-to-peak output voltage	vs Frequency	14, 15
V_{OM}	Maximum (positive/negative) peak output voltage	vs Load resistance	16, 17
		vs Free-air temperature	18, 19
A_{VD}	Large-signal differential voltage amplification	vs Supply voltage	20
		vs Load resistance	21
		vs Frequency	22 – 25
		vs Free-air temperature	26
z_o	Output impedance	vs Frequency	27
CMRR	Common-mode rejection ratio	vs Frequency	28
k_{SVR}	Supply-voltage rejection ratio	vs Frequency	29
I_{OS}	Short-circuit output current	vs Supply voltage	30, 31
		vs Elapsed time	32, 33
		vs Free-air temperature	34, 35
I_{CC}	Supply current	vs Supply voltage	36
		vs Free-air temperature	37
	Voltage-follower pulse response	Small signal	38, 40
		Large signal	39, 41
V_n	Equivalent input noise voltage	vs Frequency	42
	Noise voltage (referred to input)	Over 10-second interval	43
B_1	Unity-gain bandwidth	vs Supply voltage	44
		vs Load capacitance	45
	Gain bandwidth product	vs Supply voltage	46
		vs Load capacitance	47
SR	Slew rate	vs Free-air temperature	48, 49
ϕ_m	Phase margin	vs Supply voltage	50, 51
		vs Load capacitance	52, 53
		vs Free-air temperature	54, 55
	Phase shift	vs Frequency	22 – 25

TYPICAL CHARACTERISTICS

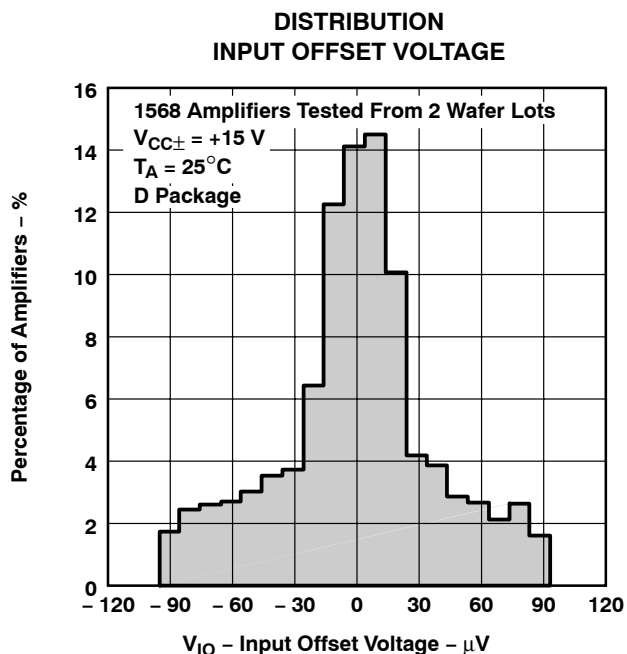


Figure 6

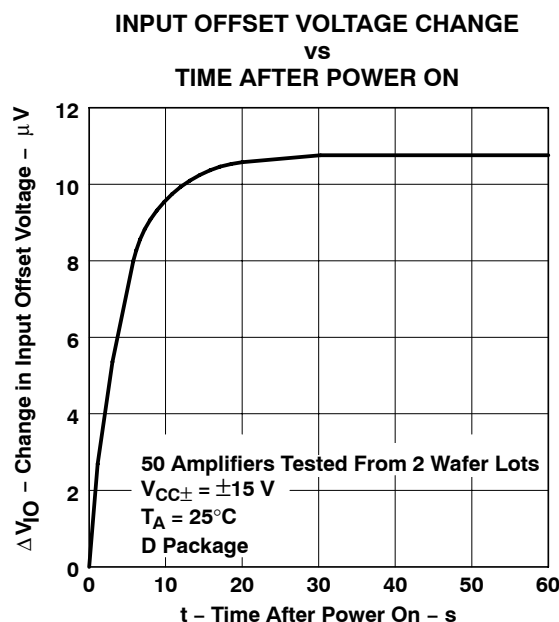


Figure 7

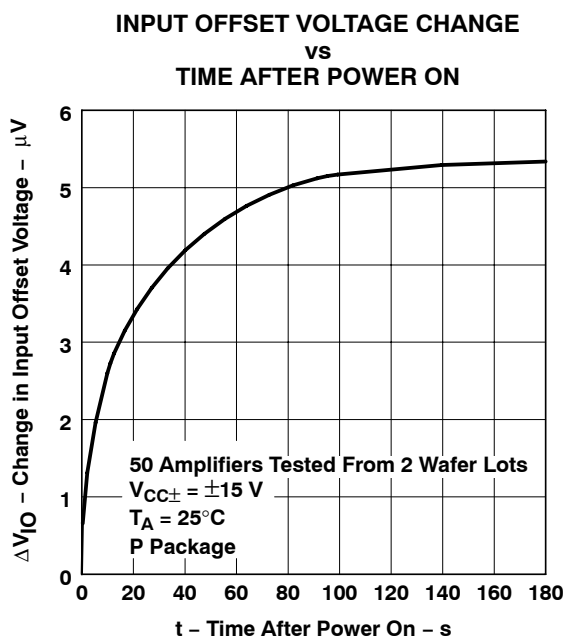


Figure 8

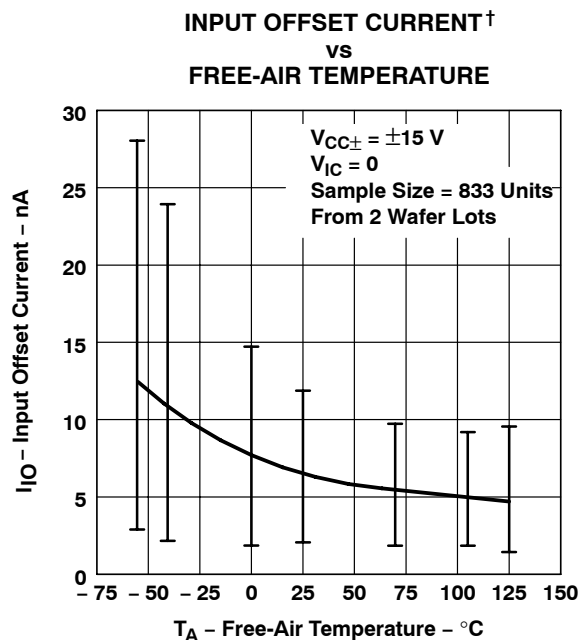


Figure 9

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

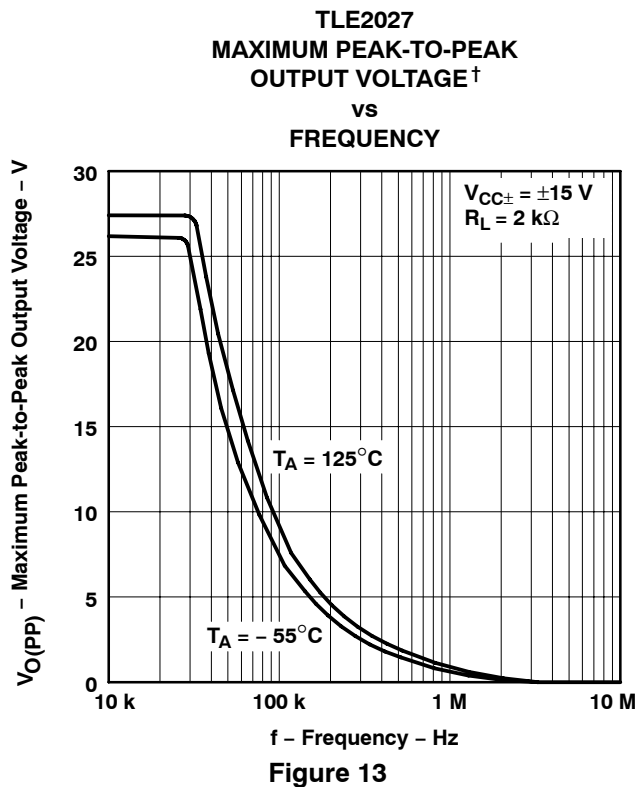
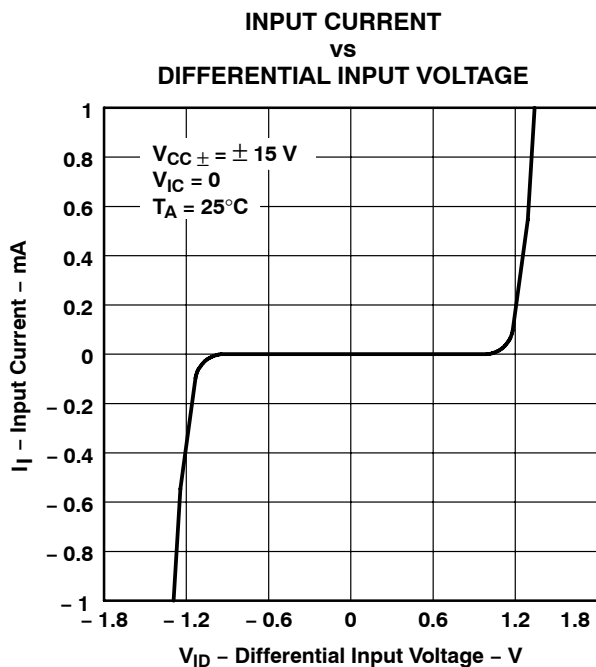
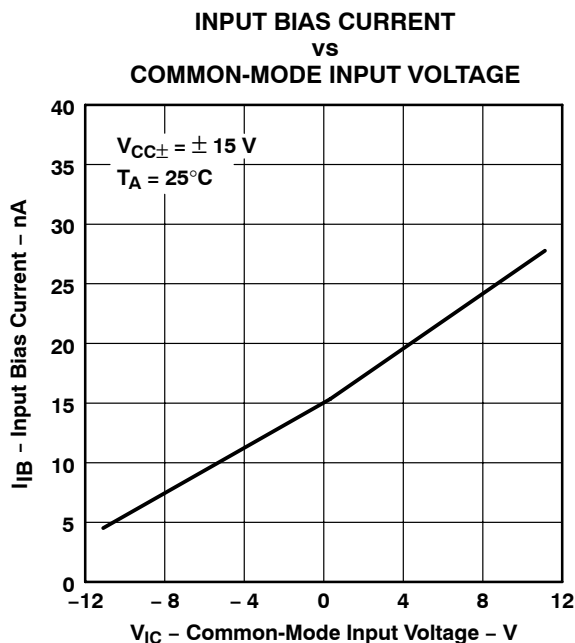
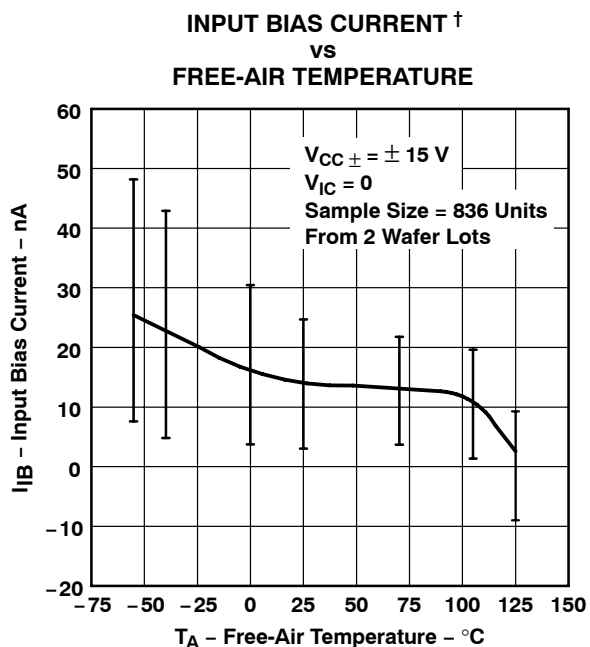
TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y

EXCALIBUR LOW-NOISE HIGH-SPEED

PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TYPICAL CHARACTERISTICS



[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS

TLE2037
MAXIMUM PEAK-TO-PEAK
OUTPUT VOLTAGE[†]
vs
FREQUENCY

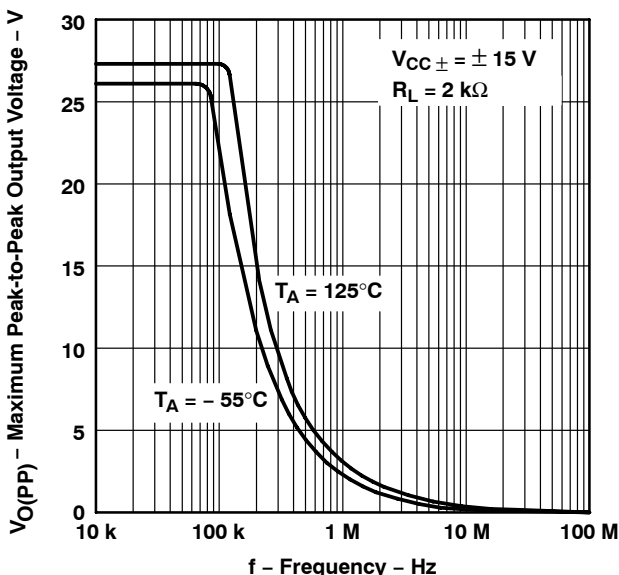


Figure 14

MAXIMUM POSITIVE PEAK
OUTPUT VOLTAGE
vs
LOAD RESISTANCE

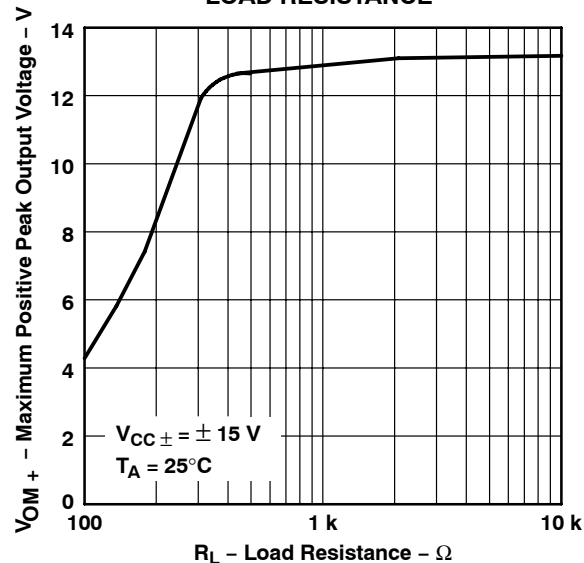


Figure 15

MAXIMUM NEGATIVE PEAK
OUTPUT VOLTAGE
vs
LOAD RESISTANCE

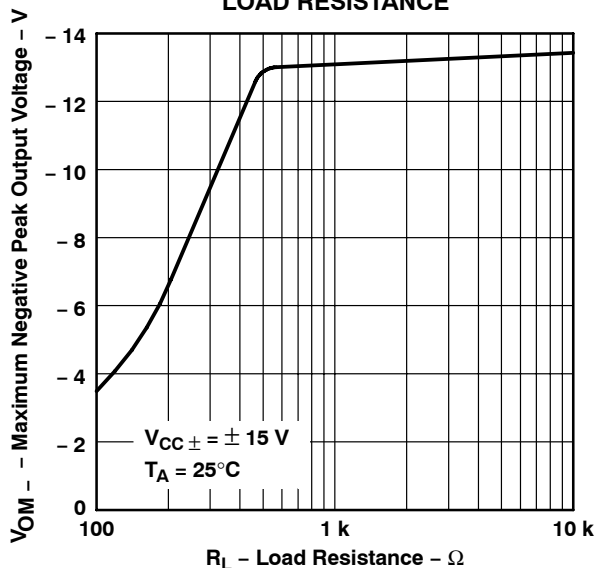


Figure 16

MAXIMUM POSITIVE PEAK
OUTPUT VOLTAGE[†]
vs
FREE-AIR TEMPERATURE

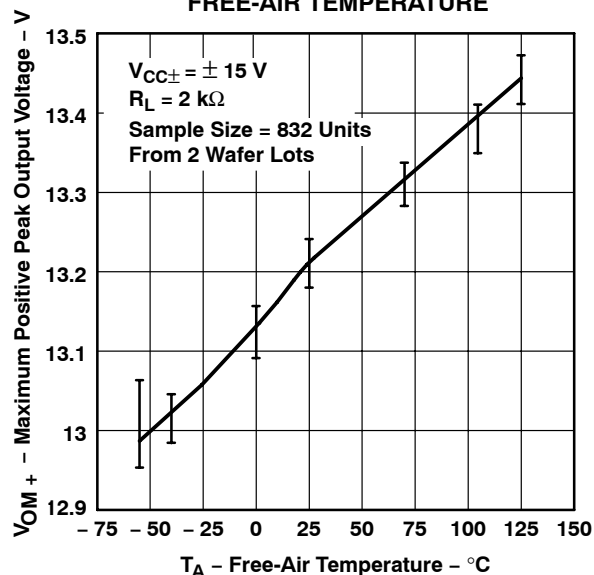


Figure 17

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y

EXCALIBUR LOW-NOISE HIGH-SPEED

PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TYPICAL CHARACTERISTICS

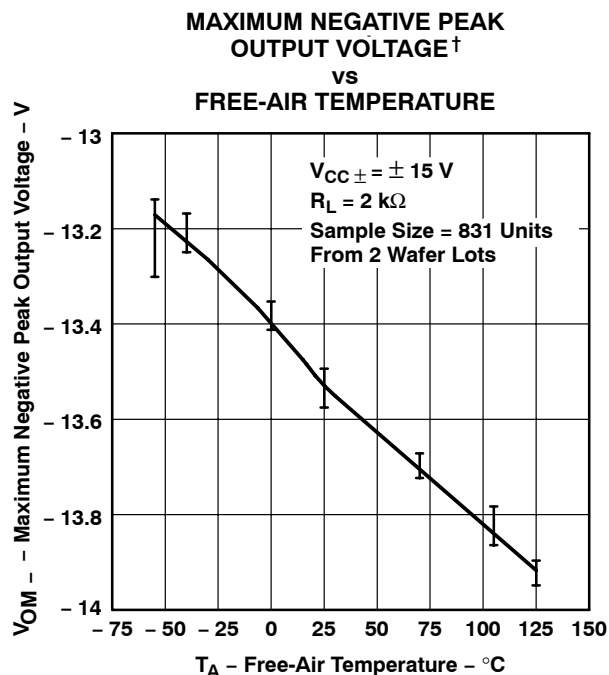


Figure 18

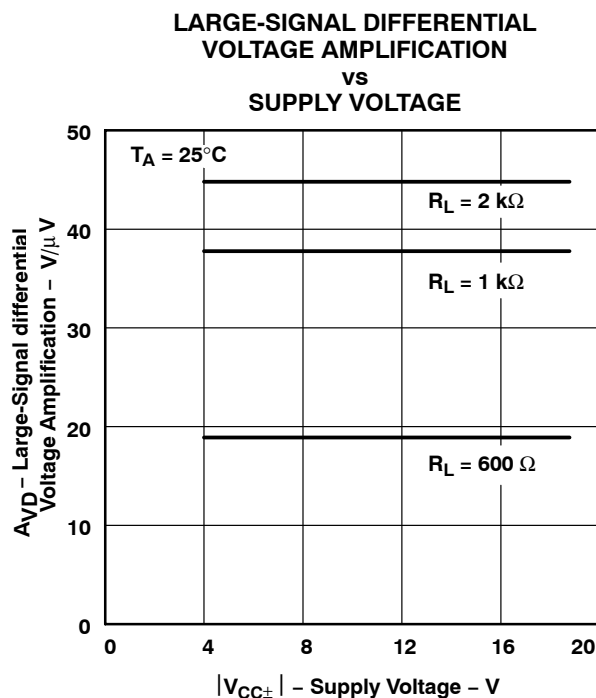


Figure 19

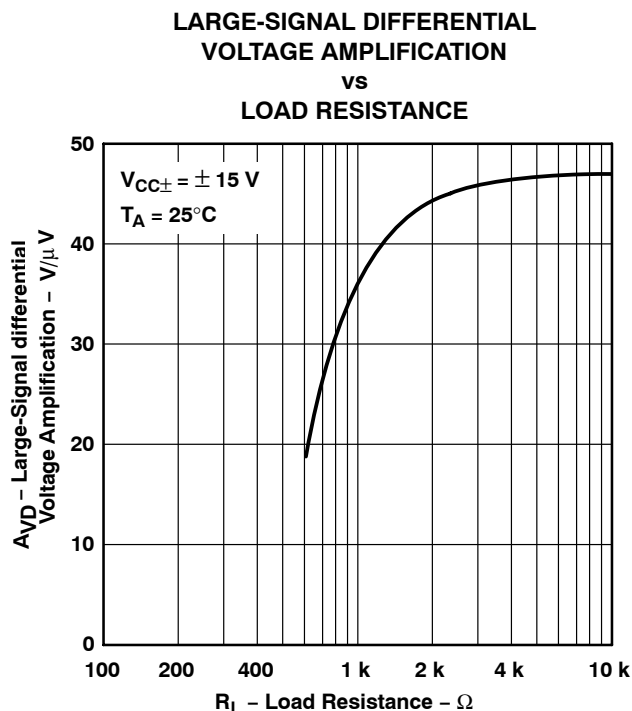


Figure 20

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS

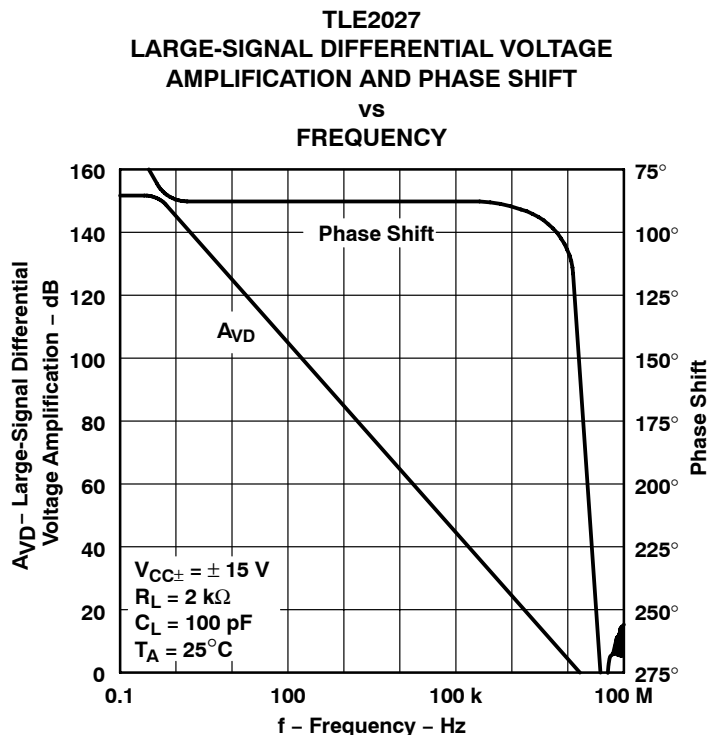


Figure 21

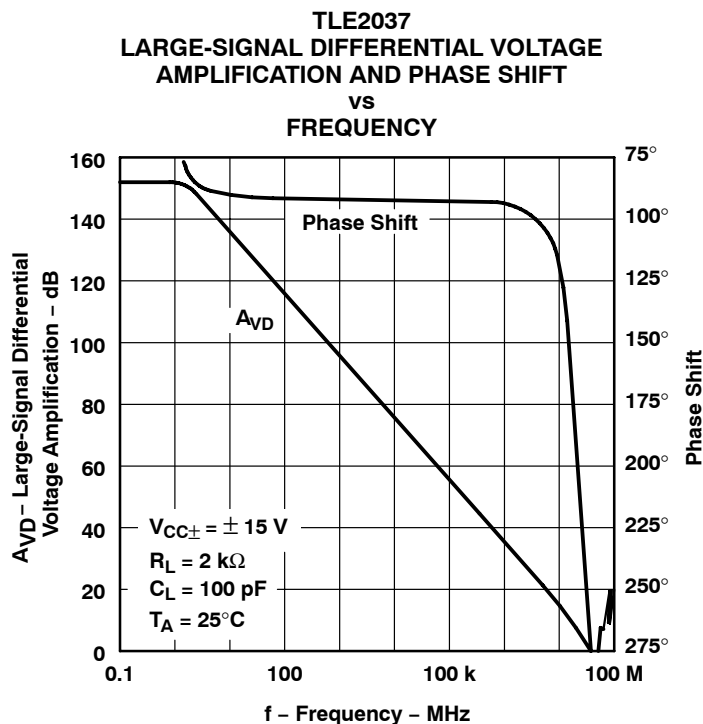


Figure 22

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y EXCALIBUR LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TYPICAL CHARACTERISTICS

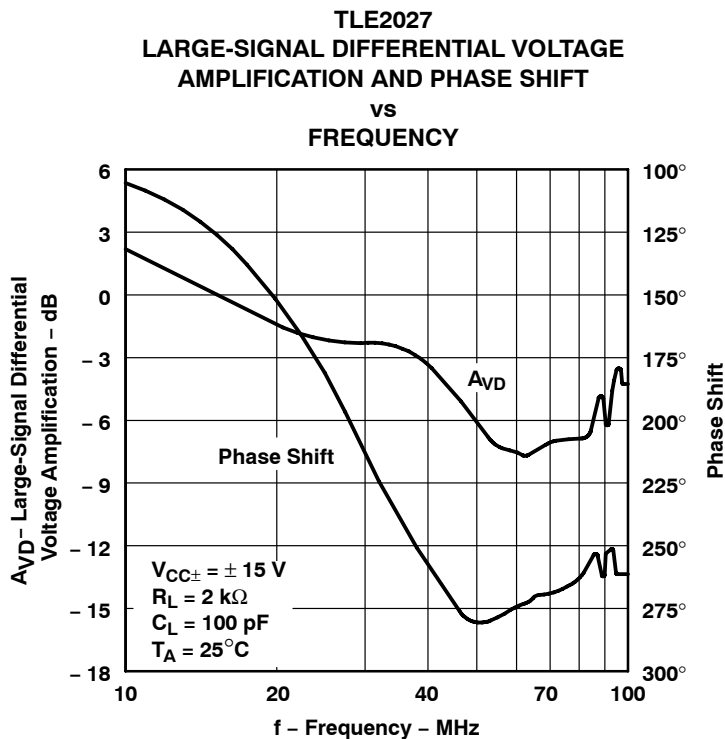


Figure 23

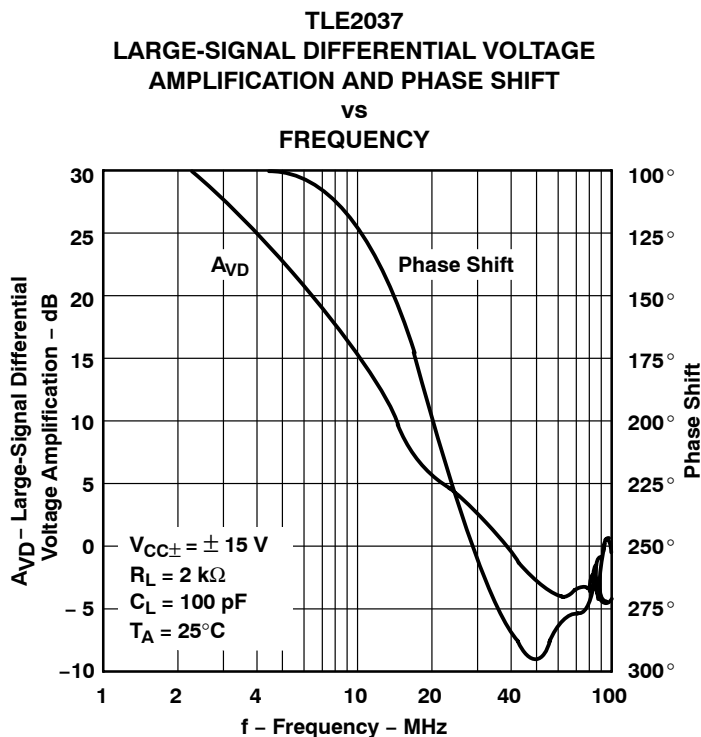


Figure 24

TYPICAL CHARACTERISTICS

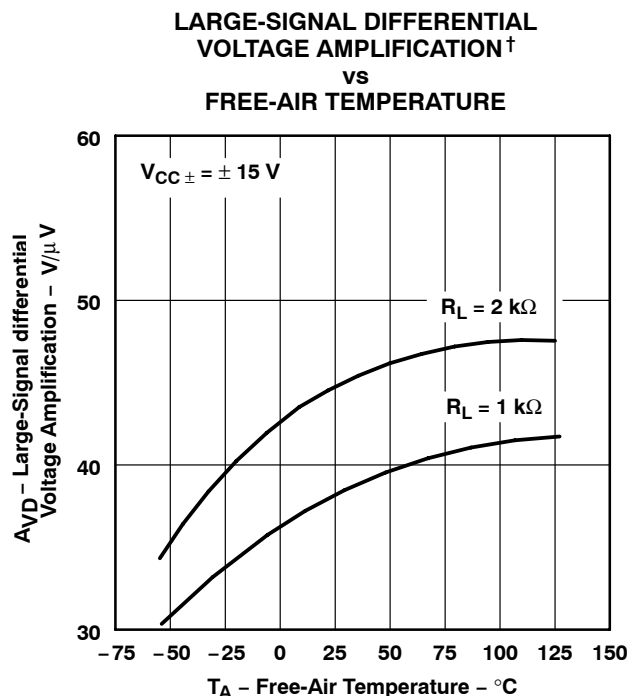
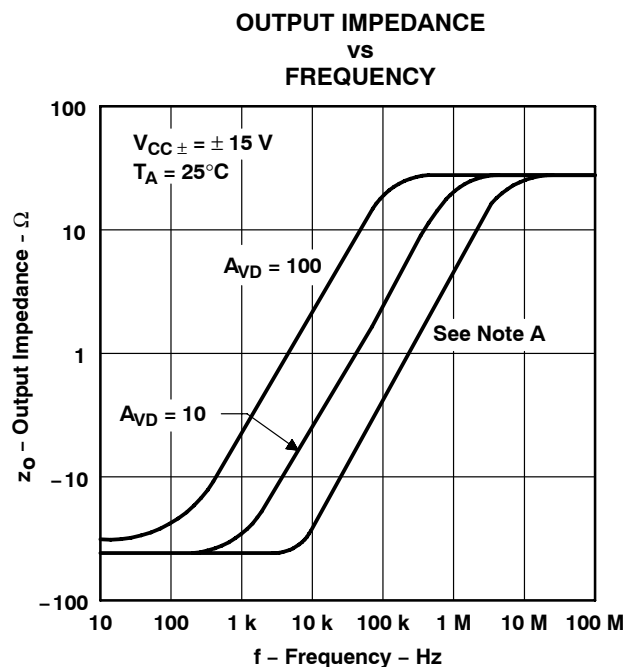


Figure 25



NOTE A: For this curve, the TLE2027 is $A_{VD} = 1$ and the TLE2037 is $A_{VD} = 5$.

Figure 26

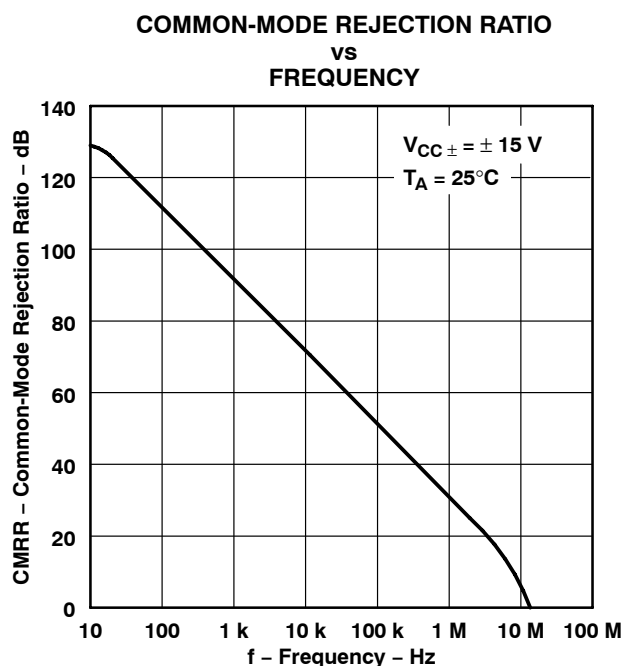


Figure 27

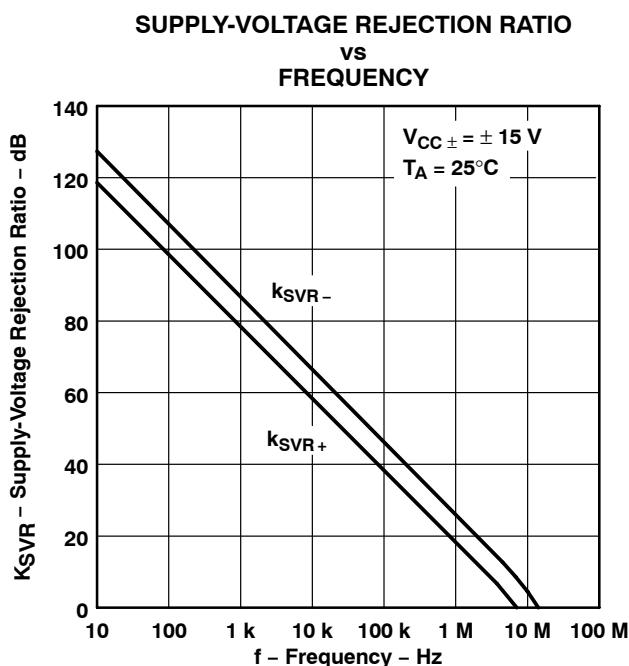


Figure 28

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y

EXCALIBUR LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TYPICAL CHARACTERISTICS

SHORT-CIRCUIT OUTPUT CURRENT
vs
SUPPLY VOLTAGE

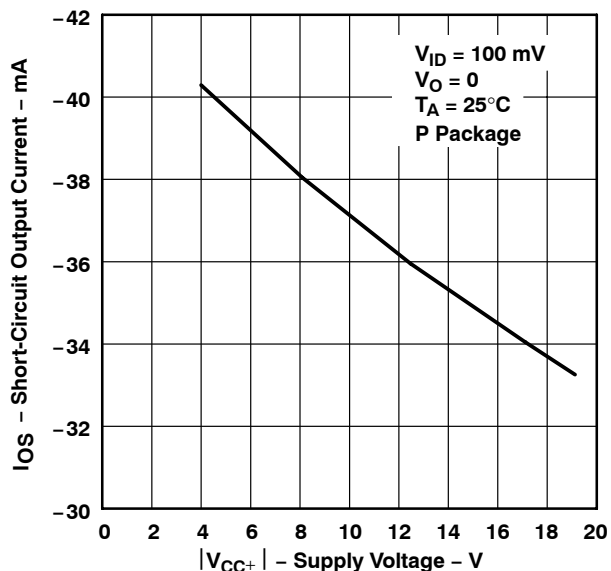


Figure 29

SHORT-CIRCUIT OUTPUT CURRENT
vs
SUPPLY VOLTAGE

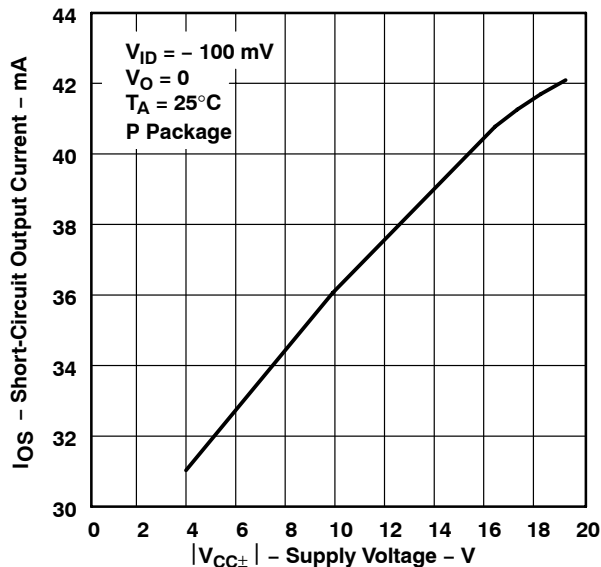


Figure 30

SHORT-CIRCUIT OUTPUT CURRENT
vs
ELAPSED TIME

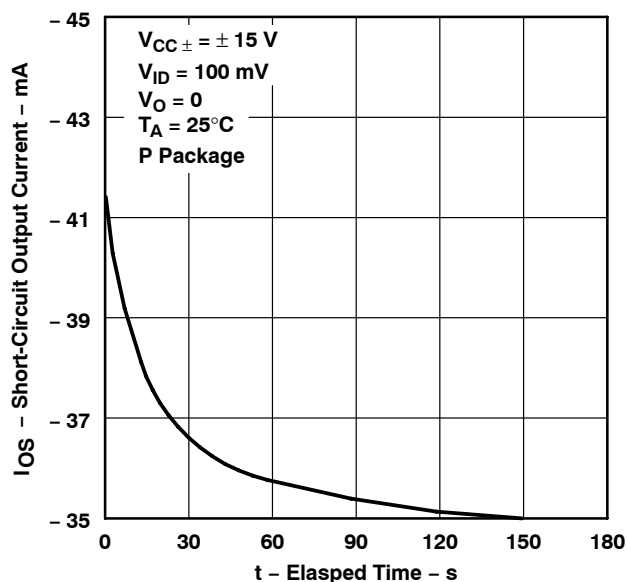


Figure 31

SHORT-CIRCUIT OUTPUT CURRENT
vs
ELAPSED TIME

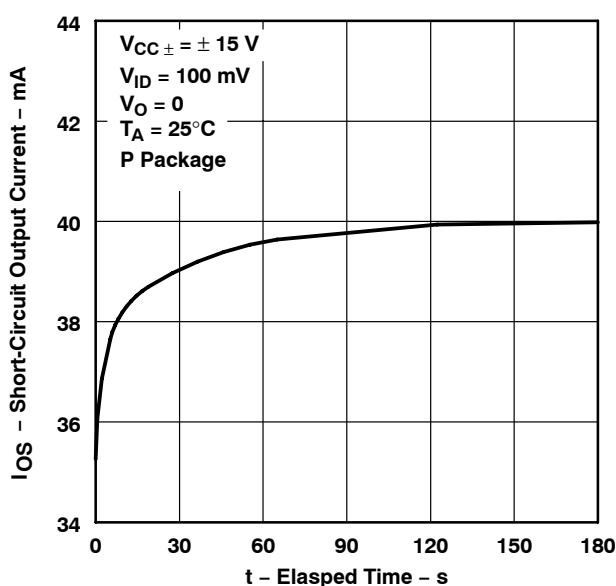


Figure 32

TYPICAL CHARACTERISTICS

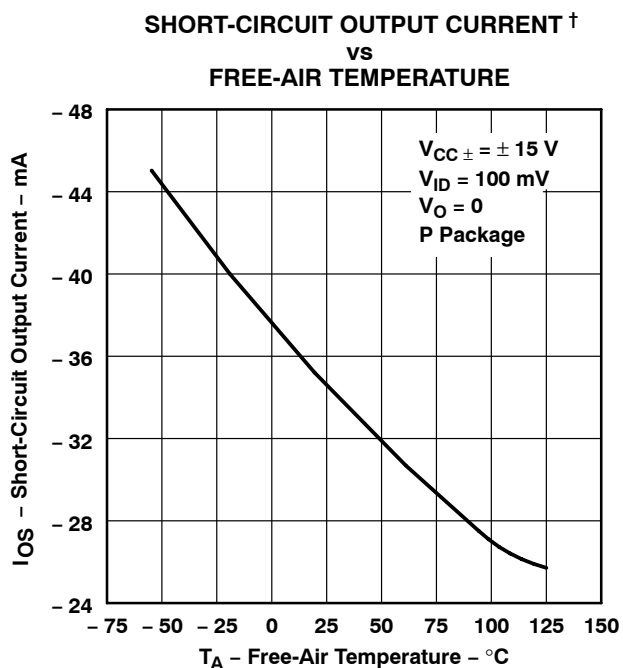


Figure 33

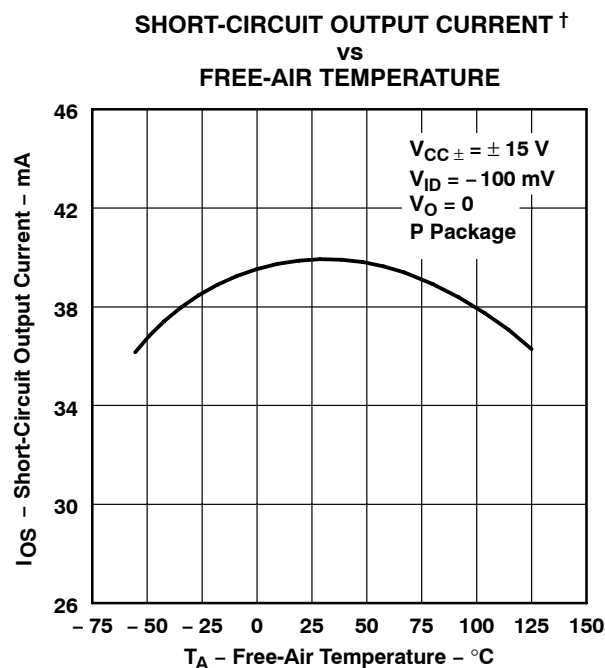


Figure 34

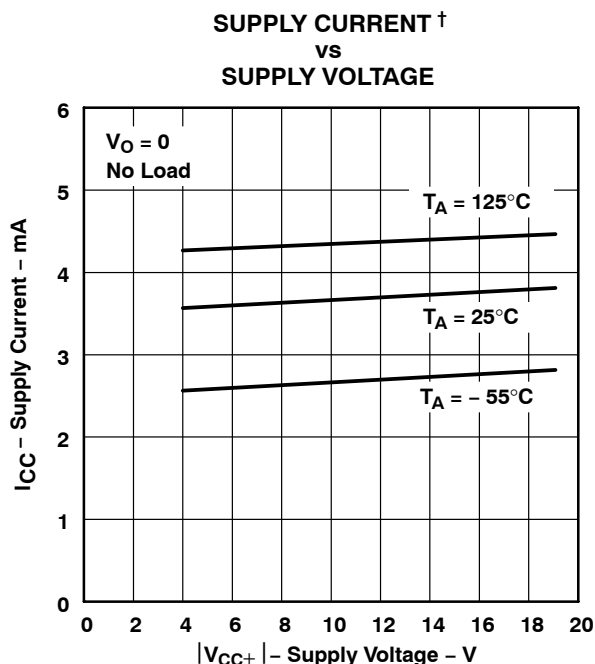


Figure 35

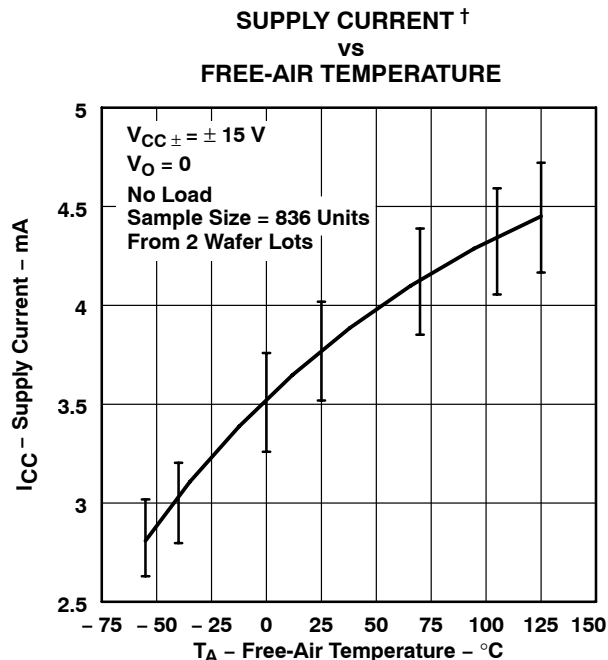


Figure 36

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y EXCALIBUR LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TYPICAL CHARACTERISTICS

**TLE2027
VOLTAGE-FOLLOWER
SMALL-SIGNAL
PULSE RESPONSE**

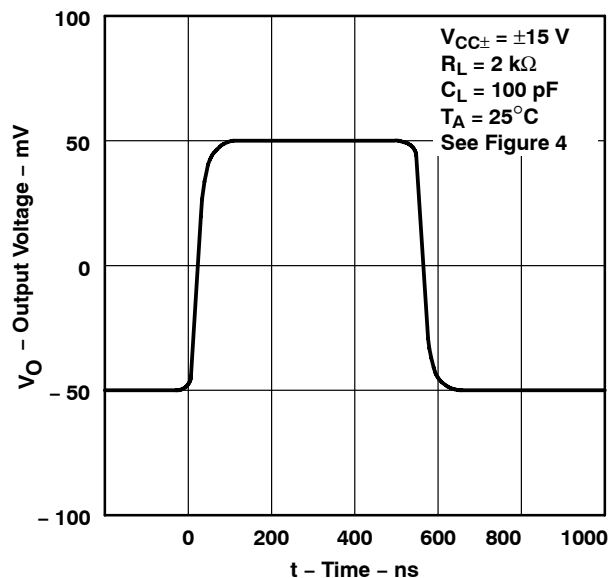


Figure 37

**TLE2027
VOLTAGE-FOLLOWER
LARGE-SIGNAL
PULSE RESPONSE**

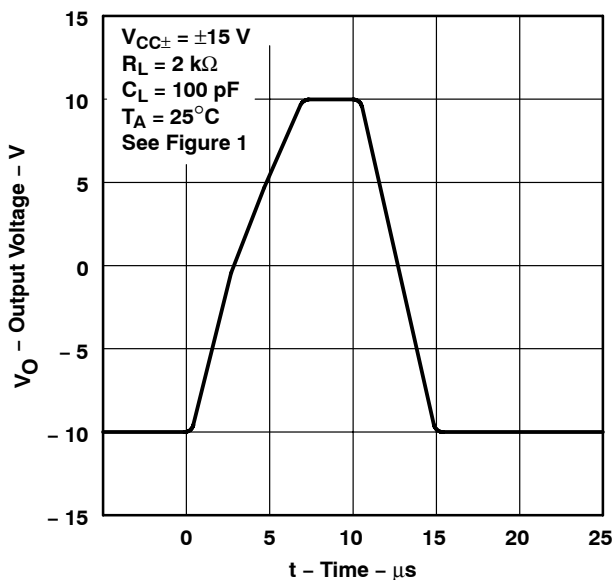


Figure 38

**TLE2037
VOLTAGE-FOLLOWER
SMALL-SIGNAL
PULSE RESPONSE**

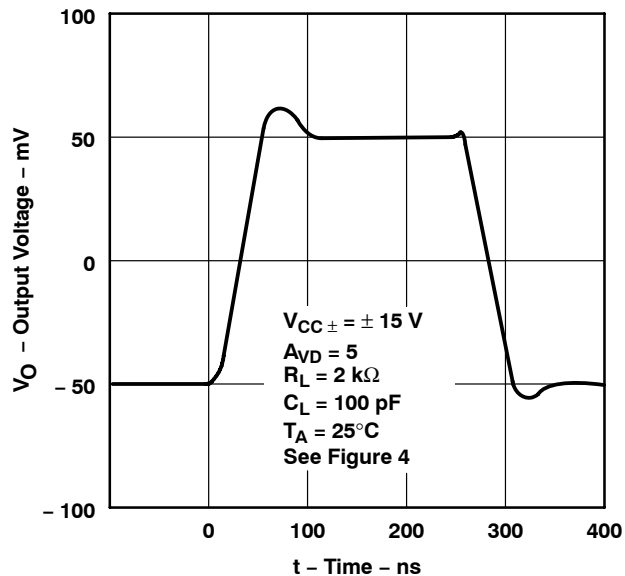


Figure 39

**TLE2037
VOLTAGE-FOLLOWER
LARGE-SIGNAL
PULSE RESPONSE**

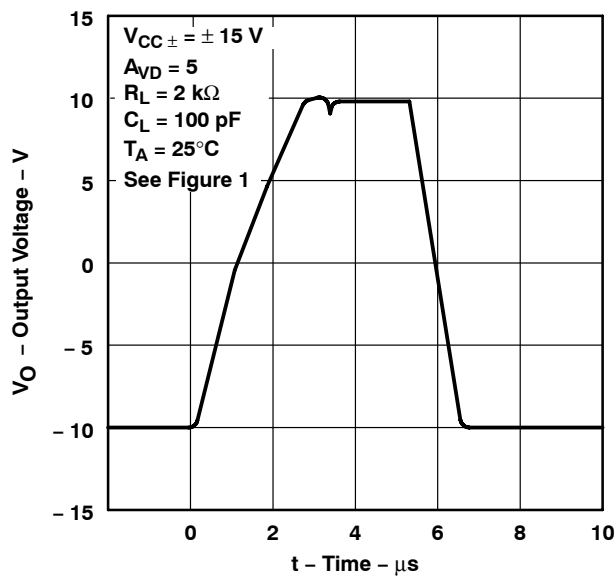


Figure 40

TYPICAL CHARACTERISTICS

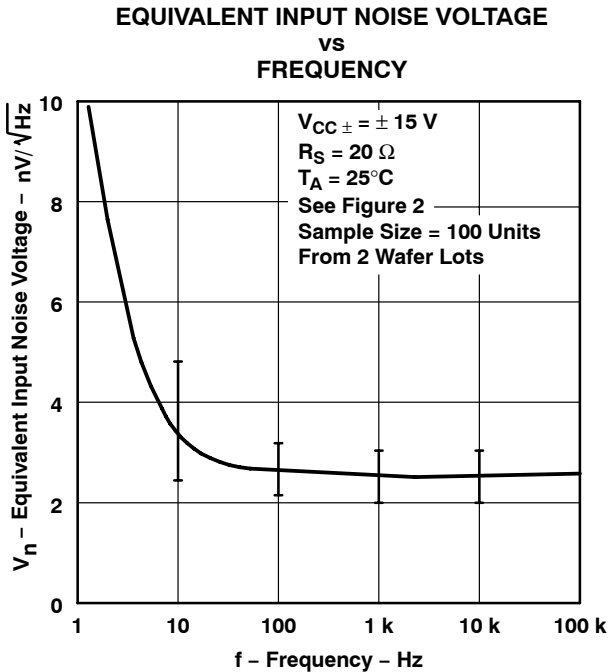


Figure 41

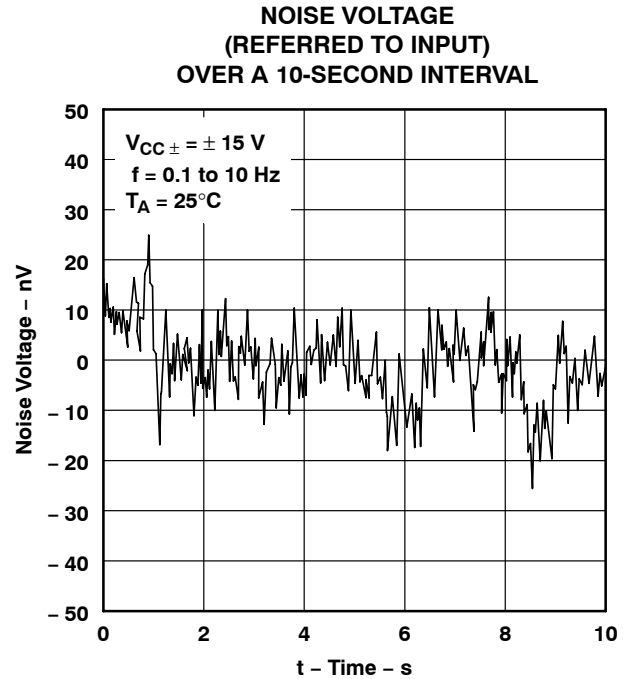


Figure 42

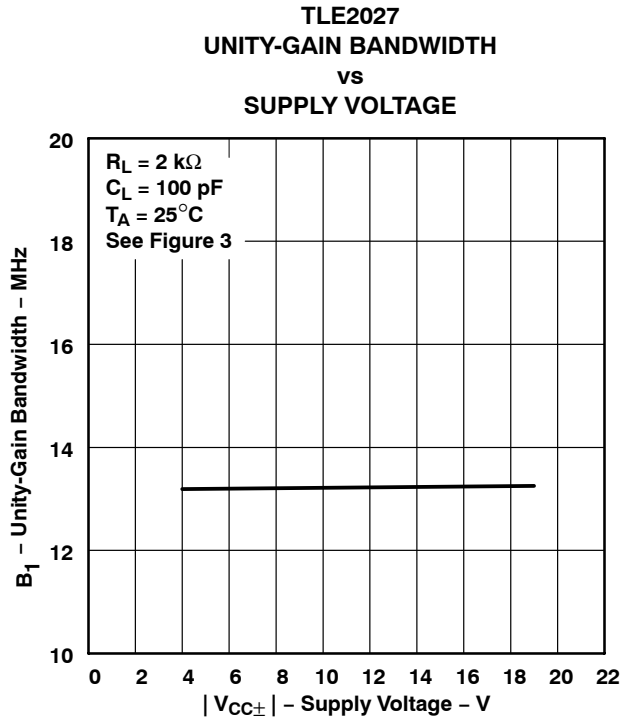


Figure 43

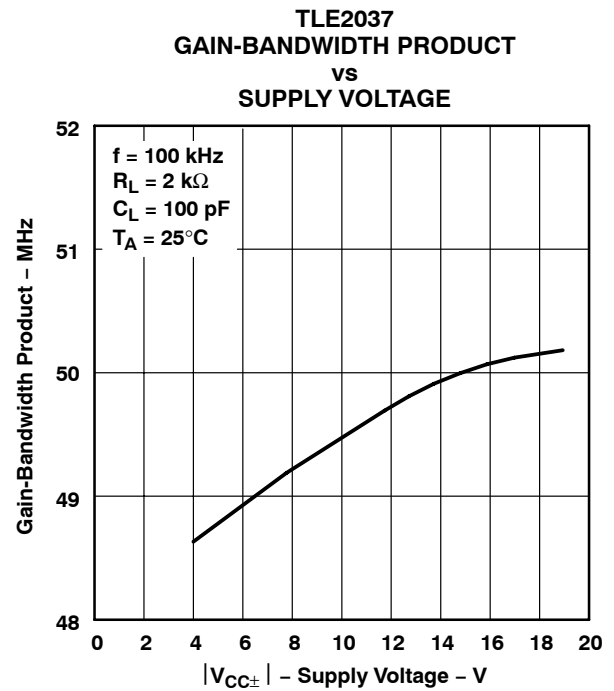


Figure 44

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y

EXCALIBUR LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TYPICAL CHARACTERISTICS

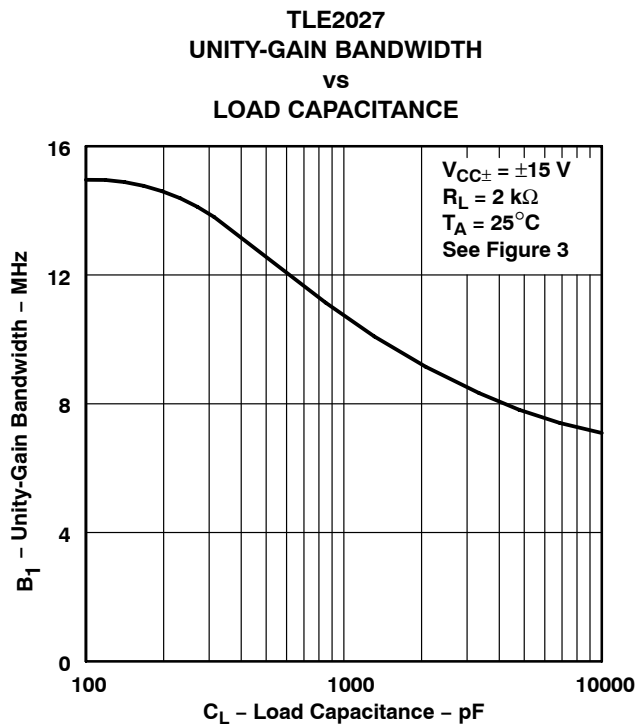


Figure 45

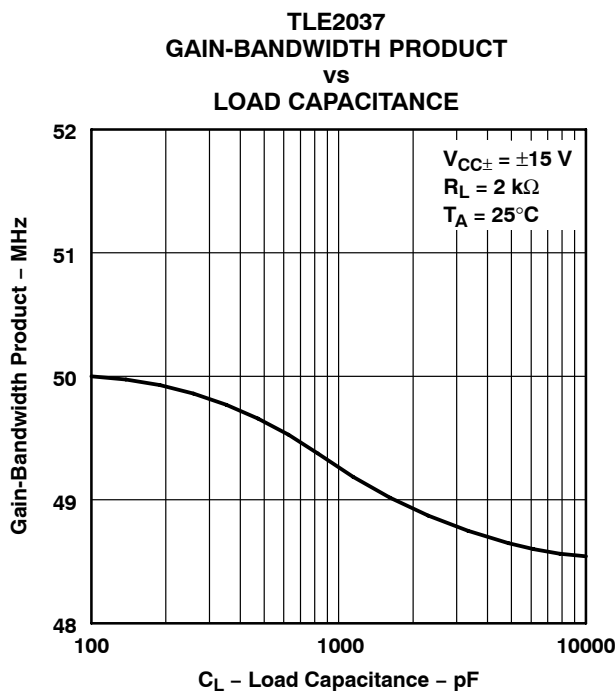


Figure 46

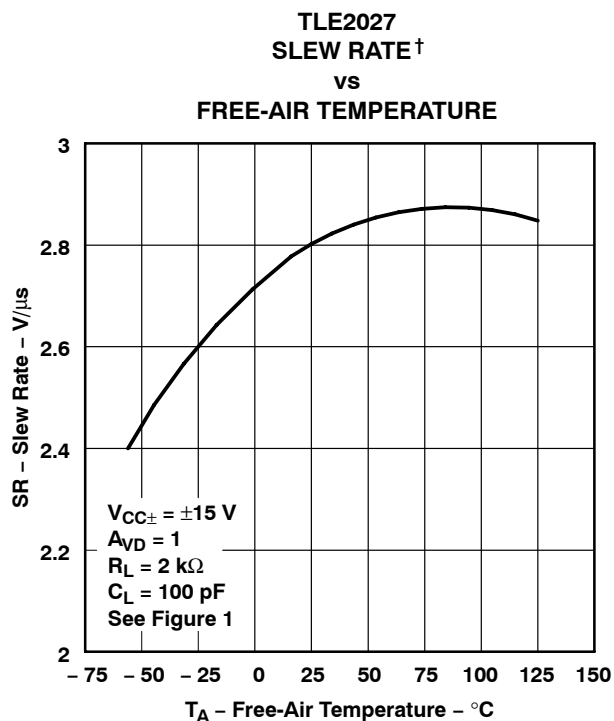


Figure 47

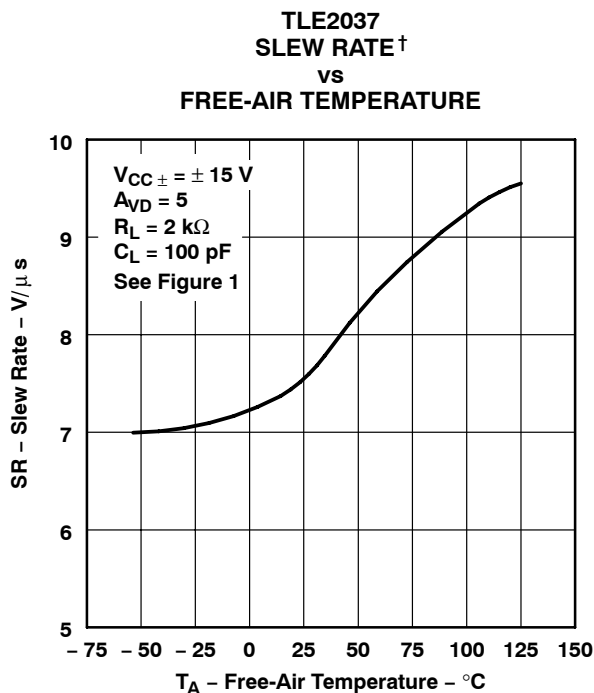


Figure 48

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS

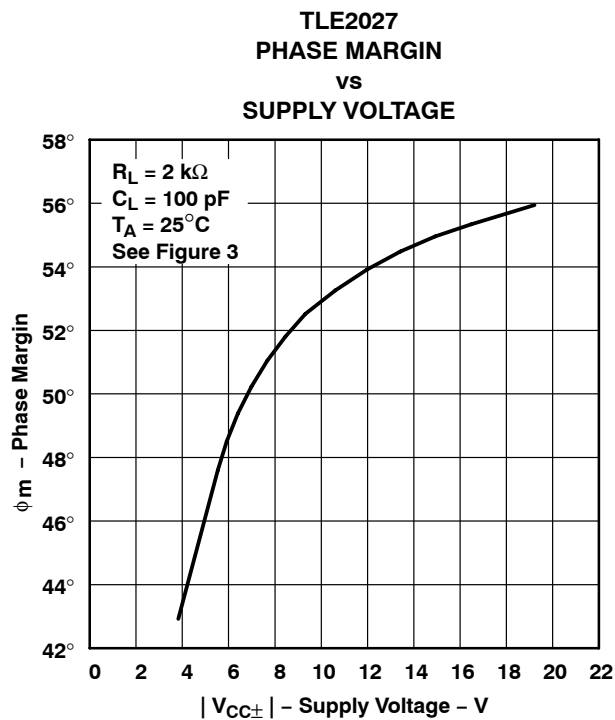


Figure 49

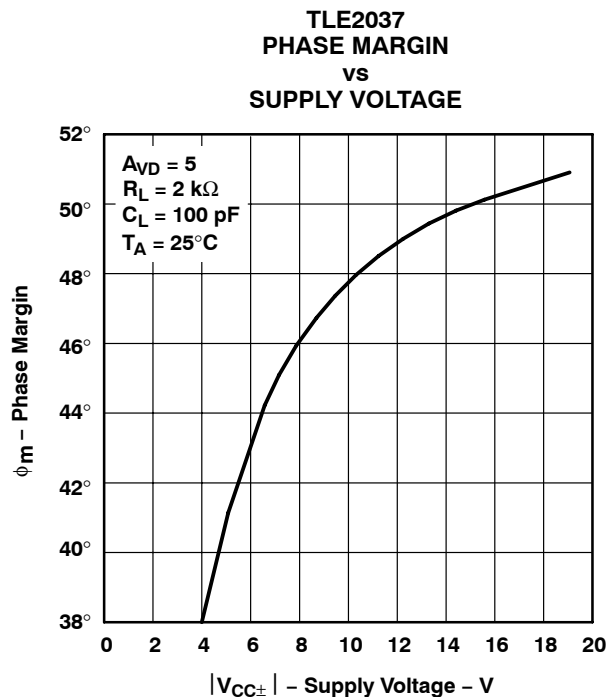


Figure 50

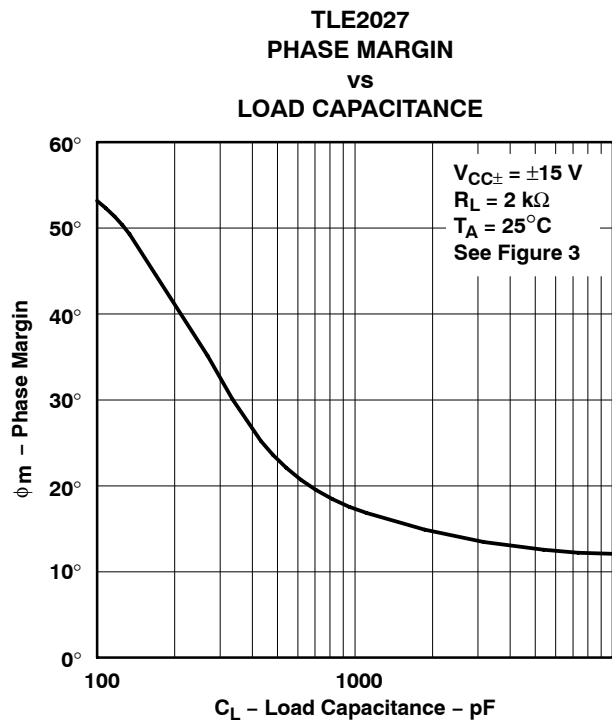


Figure 51

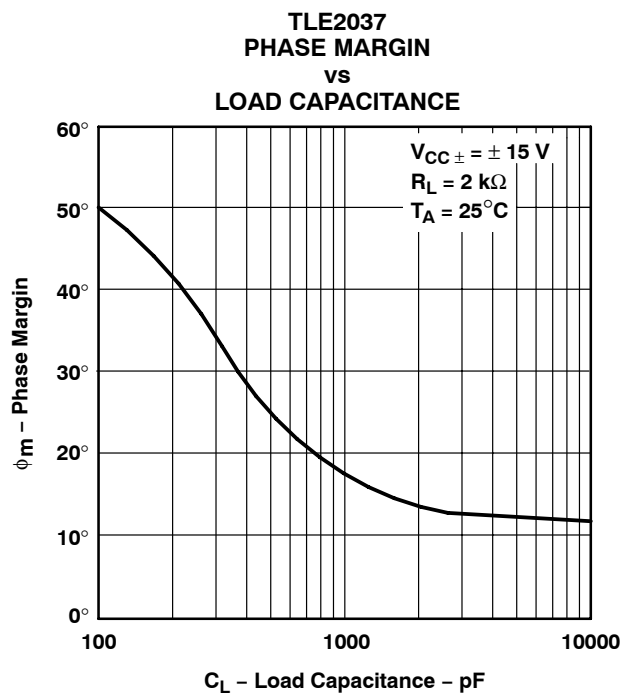


Figure 52

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y

EXCALIBUR LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

TYPICAL CHARACTERISTICS

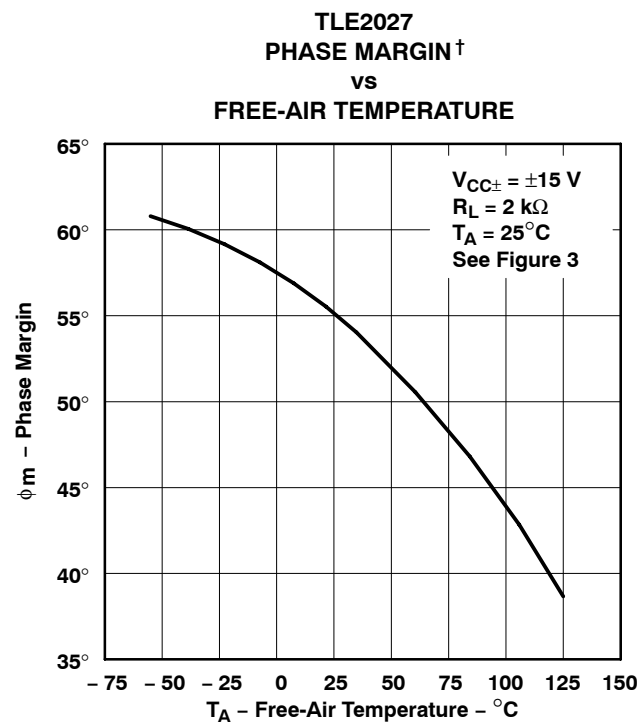


Figure 53

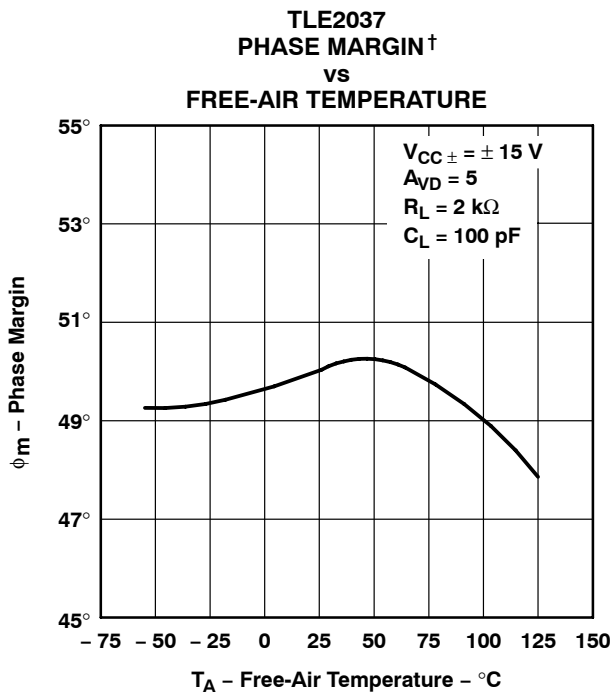


Figure 54

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

APPLICATION INFORMATION

input offset voltage nulling

The TLE2027 and TLE2037 series offers external null pins that can be used to further reduce the input offset voltage. The circuits of Figure 55 can be connected as shown if the feature is desired. If external nulling is not needed, the null pins may be left disconnected.

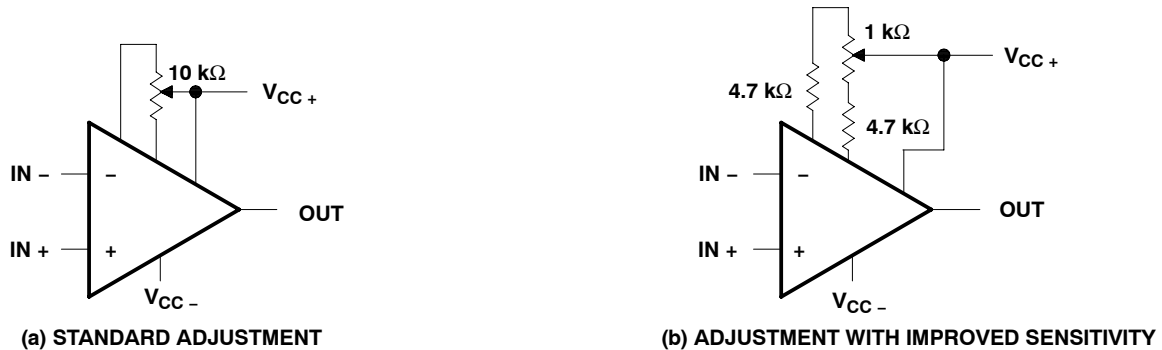


Figure 55. Input Offset Voltage Nulling Circuits

voltage-follower applications

The TLE2027 circuitry includes input-protection diodes to limit the voltage across the input transistors; however, no provision is made in the circuit to limit the current if these diodes are forward biased. This condition can occur when the device is operated in the voltage-follower configuration and driven with a fast, large-signal pulse. It is recommended that a feedback resistor be used to limit the current to a maximum of 1 mA to prevent degradation of the device. Also, this feedback resistor forms a pole with the input capacitance of the device. For feedback resistor values greater than 10 kΩ, this pole degrades the amplifier phase margin. This problem can be alleviated by adding a capacitor (20 pF to 50 pF) in parallel with the feedback resistor (see Figure 56).

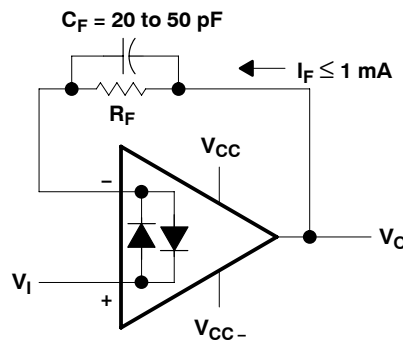


Figure 56. Voltage Follower

TLE2027, TLE2037, TLE2027A, TLE2037A, TLE2027Y, TLE2037Y EXCALIBUR LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL AMPLIFIERS

SLOS192C – FEBRUARY 1997 – REVISED APRIL 2010

APPLICATION INFORMATION

macromodel information

Macromodel information provided was derived using Microsim *Parts*™, the model generation software used with Microsim *PSpice*™. The Boyle macromodel (see Note 6) and subcircuit in Figure 57, Figure 58, and Figure 59 were generated using the TLE20x7 typical electrical and operating characteristics at 25°C. Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Gain-bandwidth product
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 6: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers", IEEE Journal of Solid-State Circuits, SC-9, 353 (1974).

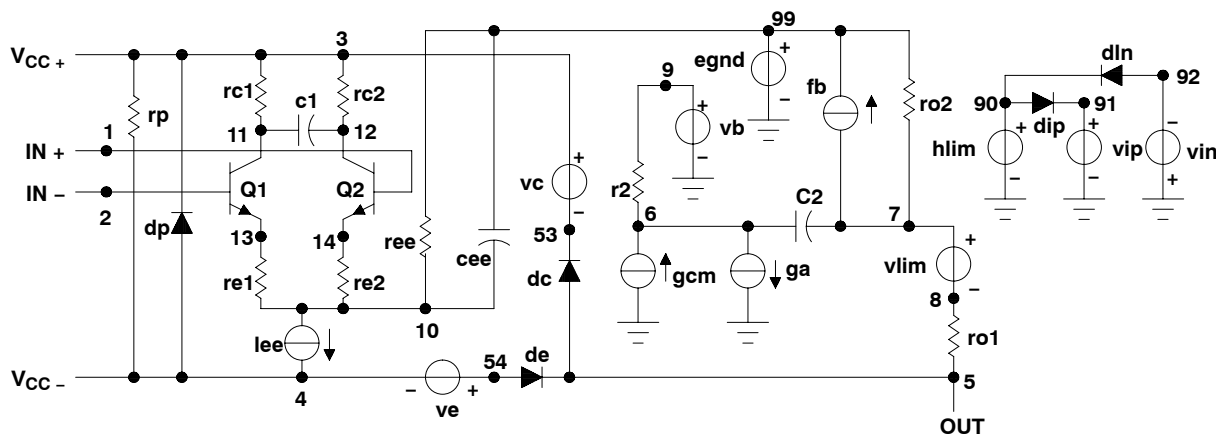


Figure 57. Boyle Macromodel

PSpice and *Parts* are trademarks of MicroSim Corporation.

APPLICATION INFORMATION

macromodel information (continued)

```
.subckt TLE2027 1 2 3 4 5
*
c1      11  12  4.003E-12
c2      6   7   20.00E-12
dc      5   53  dz
de      54  5   dz
dlp     90  91  dz
dln     92  90  dx
dp      4   3   dz
egnd    99  0   poly(2) (3,0)
(4,0) 0 5 .5
fb      7   99  poly(5) vb vc
ve vlp vln 0 954.8E6 -1E9 1E9 1E9
-1E9
ga      6   0   11  12
2.062E-3
gcm     0   6   10  99
531.3E-12
iee     10  4   dc  56.01E-6
hlim    90  0   vlim 1K
ql      11  2   13 qx

q2      12  1   14 qx
r2      6   9   100.0E3
rc1     3   11  530.5
rc2     3   12  530.5
re1     13  10  -393.2
re2     14  10  -393.2
ree     10  99  3.571E6
ro1     8   5   25
ro2     7   99  25
rp      3   4   8.013E3
vb      9   0   dc  0
vc      3   53  dc  2.400
ve      54  4   dc  2.100
vlim    7   8   dc  0
vlp     91  0   dc  40
vln     0   92  dc  40
.modeldx D(Is=800.0E-18)
.modelqx NPN(Is=800.0E-18
Bf=7.000E3)
.ends
```

Figure 58. TLE2027 Macromodel Subcircuit

```
.subckt TLE2037 1 2 3 4 5
*
c1      11  12  4.003E-12
c2      6   7   7.500E-12
dc      5   53  dz
de      54  5   dz
dlp     90  91  dz
dln     92  90  dx
dp      4   3   dz
egnd    99  0   poly(2) (3,0)
(4,0) 0 .5 .5
fb      7   99  poly(5) vb vc
ve vip vln 0 923.4E6 A800E6
800E6 800E6 A800E6
ga      6   0   11  12 2.121E-3
gcm     0   6   10  99 597.7E-12
iee     10  4   dc  56.26E-6
hlim    90  0   vlim 1K
ql      11  2   13 qx

q2      12  1   14 qz
r2      6   9   100.0E3
rc1     3   11  471.5
rc2     3   12  471.5
re1     13  10  A448
re2     14  10  A448
ree     10  99  3.555E6
ro1     8   5   25
ro2     7   99  25
rp      3   4   8.013E3
vb      9   0   dc  0
vc      3   53  dc  2.400
ve      54  4   dc  2.100
vlim    7   8   dc  0
vlp     91  0   dc  40
vln     0   92  dc  40
.model  dxD(Is=800.0E-18)
.model  qxNPN(Is=800.0E-18
Bf=7.031E3)
.ends
```

Figure 59. TLE2037 Macromodel Subcircuit

REVISION HISTORY

Changes from Revision B (October 2006) to Revision C

- Changed values of V_n , $V_{N(PP)}$, and I_n 11

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962-9089601M2A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 9089601M2A TLE2027MFKB
5962-9089601MPA	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	9089601MPA TLE2027M
5962-9089603Q2A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 9089603Q2A TLE2027AMFKB
5962-9089603QPA	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	9089603QPA TLE2027AM
TLE2027AMD	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	2027AM
TLE2027AMD.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	2027AM
TLE2027AMFKB	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 9089603Q2A TLE2027AMFKB
TLE2027AMFKB.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 9089603Q2A TLE2027AMFKB
TLE2027AMJG	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	TLE2027 AMJG
TLE2027AMJG.A	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	TLE2027 AMJG
TLE2027AMJGB	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	9089603QPA TLE2027AM
TLE2027AMJGB.A	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	9089603QPA TLE2027AM
TLE2027CD	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-	2027C
TLE2027CD.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	2027C
TLE2027CDR	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	2027C
TLE2027CDR.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	2027C
TLE2027ID	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-	2027I
TLE2027ID.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	2027I
TLE2027IDR	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-	2027I

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TLE2027IDR.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	2027I
TLE2027MD	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	2027M
TLE2027MD.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	2027M
TLE2027MFKB	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 9089601M2A TLE2027MFKB
TLE2027MFKB.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 9089601M2A TLE2027MFKB
TLE2027MJGB	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	9089601MPA TLE2027M
TLE2027MJGB.A	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	9089601MPA TLE2027M
TLE2037AMD	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	2037AM
TLE2037AMD.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	2037AM
TLE2037AMDG4	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	2037AM
TLE2037AMDG4.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	2037AM
TLE2037CD	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-	2037C
TLE2037CD.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	2037C
TLE2037CDR	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-	2037C
TLE2037CDR.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	2037C
TLE2037ID	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-	2037I
TLE2037ID.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	2037I
TLE2037IDR	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-	2037I
TLE2037IDR.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	2037I
TLE2037MD	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	2037M
TLE2037MD.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	2037M

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF TLE2027, TLE2027M, TLE2037A :

- Catalog : [TLE2027](#)
- Automotive : [TLE2037A-Q1](#)
- Enhanced Product : [TLE2027-EP](#), [TLE2027-EP](#)
- Military : [TLE2027M](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

- Enhanced Product - Supports Defense, Aerospace and Medical Applications
- Military - QML certified for Military and Defense Applications

TAPE AND REEL INFORMATION



*All dimensions are nominal

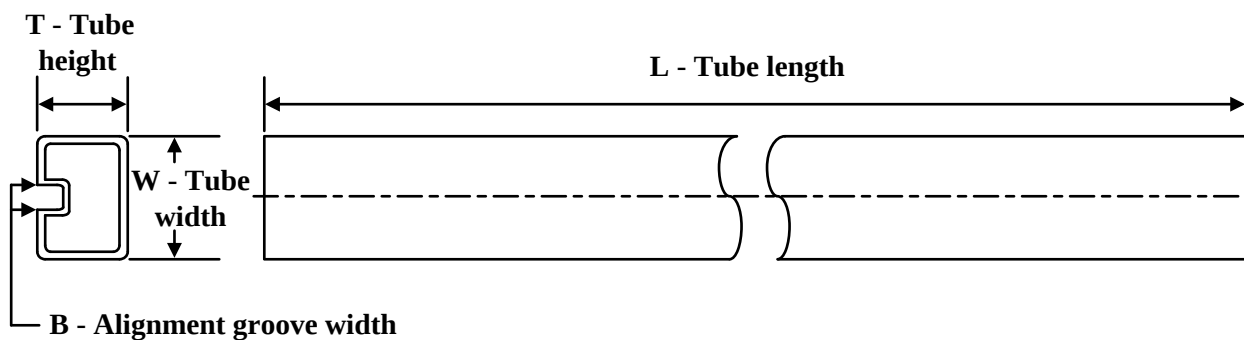
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLE2027CDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2027IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2037CDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2037IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLE2027CDR	SOIC	D	8	2500	353.0	353.0	32.0
TLE2027IDR	SOIC	D	8	2500	353.0	353.0	32.0
TLE2037CDR	SOIC	D	8	2500	353.0	353.0	32.0
TLE2037IDR	SOIC	D	8	2500	353.0	353.0	32.0

TUBE


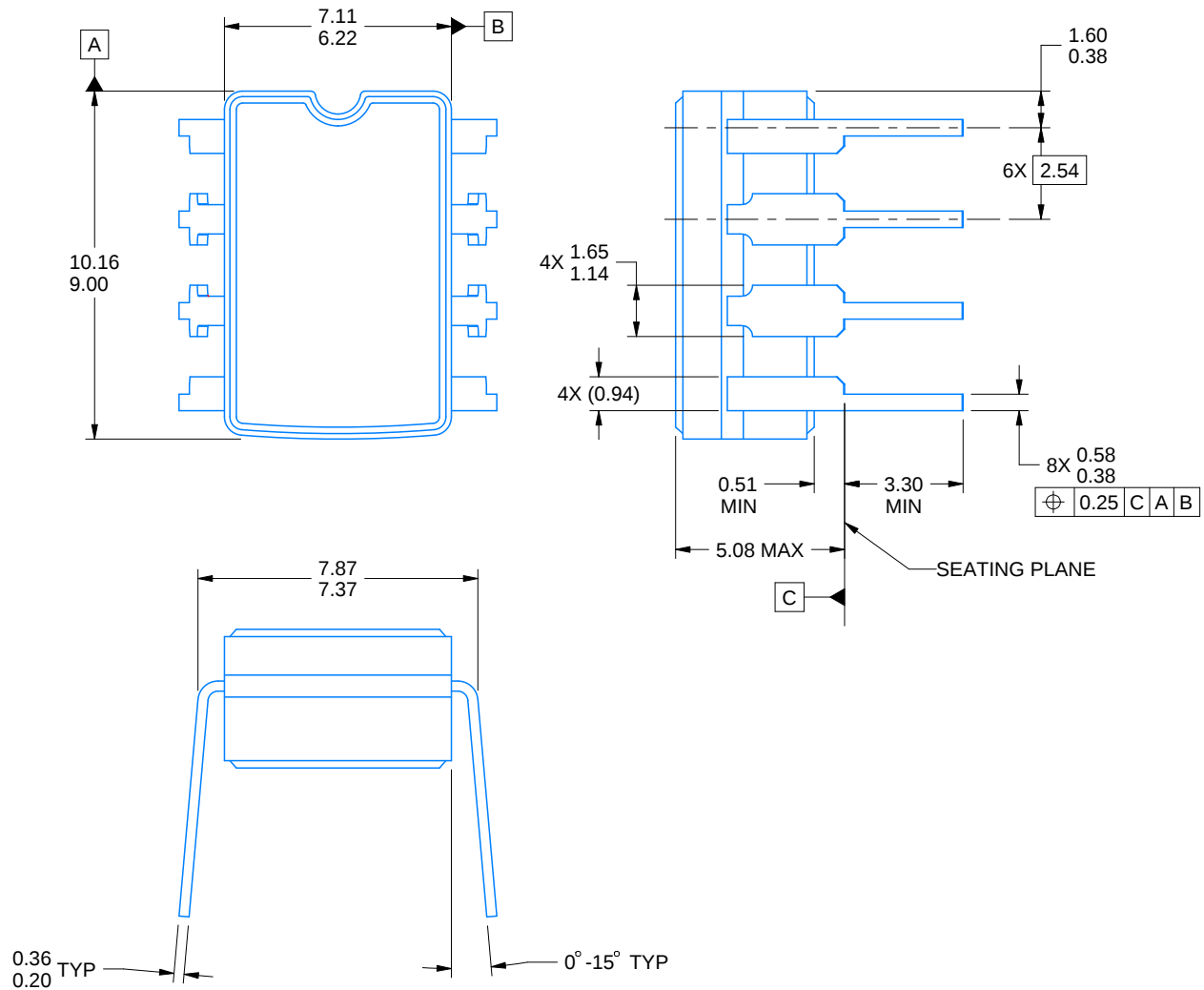
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
5962-9089601M2A	FK	LCCC	20	55	506.98	12.06	2030	NA
5962-9089603Q2A	FK	LCCC	20	55	506.98	12.06	2030	NA
TLE2027AMD	D	SOIC	8	75	505.46	6.76	3810	4
TLE2027AMD.A	D	SOIC	8	75	505.46	6.76	3810	4
TLE2027AMFKB	FK	LCCC	20	55	506.98	12.06	2030	NA
TLE2027AMFKB.A	FK	LCCC	20	55	506.98	12.06	2030	NA
TLE2027CD	D	SOIC	8	75	505.46	6.76	3810	4
TLE2027CD	D	SOIC	8	75	507	8	3940	4.32
TLE2027CD.A	D	SOIC	8	75	507	8	3940	4.32
TLE2027CD.A	D	SOIC	8	75	505.46	6.76	3810	4
TLE2027ID	D	SOIC	8	75	505.46	6.76	3810	4
TLE2027ID	D	SOIC	8	75	507	8	3940	4.32
TLE2027ID.A	D	SOIC	8	75	507	8	3940	4.32
TLE2027ID.A	D	SOIC	8	75	505.46	6.76	3810	4
TLE2027MD	D	SOIC	8	75	505.46	6.76	3810	4
TLE2027MD.A	D	SOIC	8	75	505.46	6.76	3810	4
TLE2027MFKB	FK	LCCC	20	55	506.98	12.06	2030	NA
TLE2027MFKB.A	FK	LCCC	20	55	506.98	12.06	2030	NA
TLE2037AMD	D	SOIC	8	75	505.46	6.76	3810	4
TLE2037AMD.A	D	SOIC	8	75	505.46	6.76	3810	4
TLE2037AMDG4	D	SOIC	8	75	505.46	6.76	3810	4
TLE2037AMDG4.A	D	SOIC	8	75	505.46	6.76	3810	4
TLE2037CD	D	SOIC	8	75	505.46	6.76	3810	4
TLE2037CD	D	SOIC	8	75	507	8	3940	4.32
TLE2037CD.A	D	SOIC	8	75	507	8	3940	4.32
TLE2037CD.A	D	SOIC	8	75	505.46	6.76	3810	4
TLE2037ID	D	SOIC	8	75	505.46	6.76	3810	4
TLE2037ID	D	SOIC	8	75	507	8	3940	4.32
TLE2037ID.A	D	SOIC	8	75	507	8	3940	4.32

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
TLE2037ID.A	D	SOIC	8	75	505.46	6.76	3810	4
TLE2037MD	D	SOIC	8	75	505.46	6.76	3810	4
TLE2037MD.A	D	SOIC	8	75	505.46	6.76	3810	4

JG0008A**PACKAGE OUTLINE****CDIP - 5.08 mm max height**

CERAMIC DUAL IN-LINE PACKAGE



4230036/A 09/2023

NOTES:

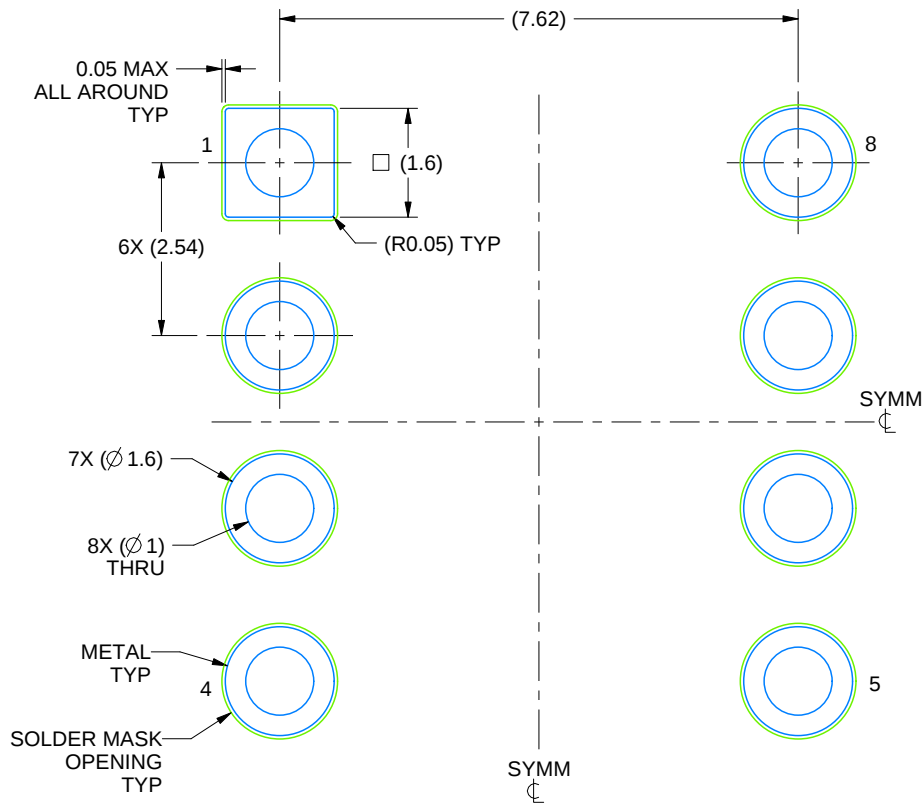
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package can be hermetically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification.
5. Falls within MIL STD 1835 GDIP1-T8

EXAMPLE BOARD LAYOUT

JG0008A

CDIP - 5.08 mm max height

CERAMIC DUAL IN-LINE PACKAGE



LAND PATTERN EXAMPLE
NON SOLDER MASK DEFINED
SCALE: 9X

4230036/A 09/2023

GENERIC PACKAGE VIEW

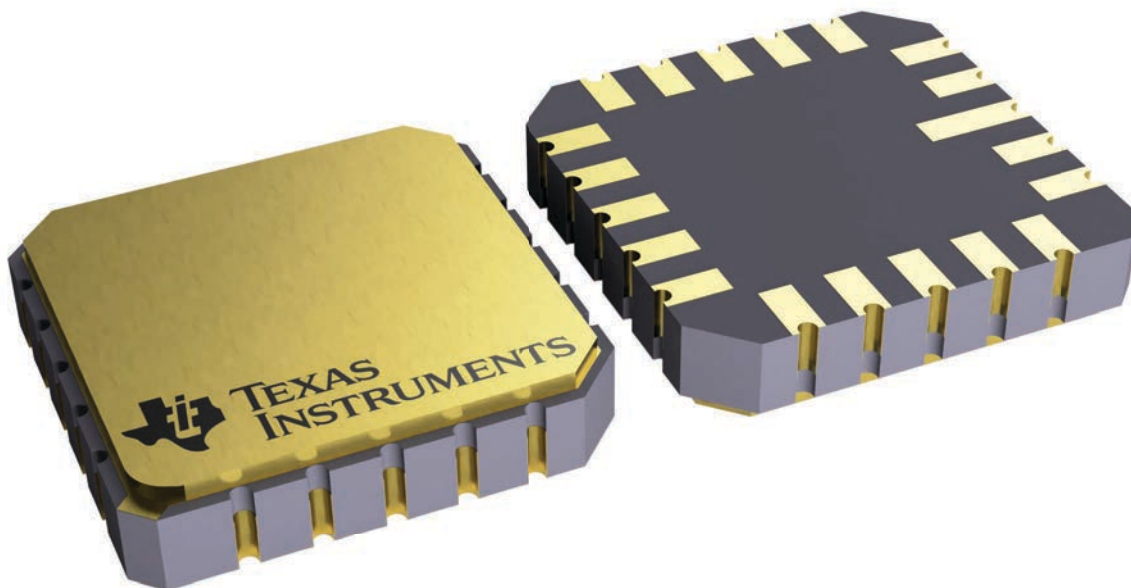
FK 20

LCCC - 2.03 mm max height

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



4229370VA\



PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON .005 INCH [0.125 MM] THICK STENCIL
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2025, Texas Instruments Incorporated